Ceramic Resonators (CERALOCK®)

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• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

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EU RoHS Compliant

· All the products in this catalog comply with EU RoHS.
· EU RoHS is "the European Directive 2011/65/EU on the Restriction of the Use
 of Certain Hazardous Substances in Electrical and Electronic Equipment."
· For more details, please refer to our website 'Murata's Approach for EU RoHS'
 (http://www.murata.com/en-eu/support/compliance/rohs).

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Contents

Product specifications are as of March 2015.

CERALOCK®, CERALOCK(R) and "CERALOCK"
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Murata Manufacturing Co., Ltd.

Please check the MURATA home page (http://www.murata.com/)
if you cannot find the part number in the catalog.

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Selection Guide

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                              ┌─────────────────────┐
                              │    Applications     │
                              └─────────────────────┘
```

Automotive

Tight Tolerance

SMD

	CSTCR_G15C 4.00–7.99MHz
	CSTCE_G15C 8.00–13.99MHz
	CSTCE_V13C 14.00–20.00MHz

Standard Tolerance

SMD

	CSTCC_G_A 2.00–3.99MHz
	CSTCR_G_B 4.00–7.99MHz
	CSTCE_G_A 8.00–13.99MHz
	CSTCE_V_C 14.00–20.00MHz
	CSTCV_X_Q 20.01–70.00MHz
	CSACV_X_Q 20.01–70.00MHz (Two Terminals)

Consumer/Industrial

Tight Tolerance

SMD

	CSTCR_G15L CSTCR_GH5L 4.00–7.99MHz
	CSTCE_G15L CSTCE_GH5L 8.00–13.99MHz
	CSTCE_V13L CSTCE_VH3L 14.00–20.00MHz
	CSTCW_X11 20.01–48.00MHz

Standard Tolerance

SMD

	CSTCC_G 2.00–3.99MHz
	CSTCR_G 4.00–7.99MHz
	CSACN_G 4.00/6.00MHz
	CSTCE_G 8.00–13.99MHz
	CSACM_G 8.00/10.00/12.00MHz
	CSTCE_V 14.00–20.00MHz
	CSTCW_X 20.01–70.00MHz
	CSACW_X 20.01–70.00MHz (Two Terminals)
	CSTCG_V 20.00–33.86MHz *Super Small!*

Leaded

	CSTLS_G 3.40–10.00MHz
	CSTLS_X 16.00–70.00MHz

Notice: "CERALOCK® for consumer" and "CERALOCK® for automotive" is different in the specification of Operating Temperature Range, Environmental Characteristics, Physical Characteristics and so on. Please choose either "for consumer" or "for automotive" according to the required specification.

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● **Part Numbering**

CERALOCK® (MHz)

(Part Number) | CS | T | CE | 16M0 | V | 5 | 3 | *** | -R0 |
❶ ❷ ❸ ❹ ❺ ❻ ❼ ❽ ❾

❶Product ID

Product ID	
CS	Ceramic Resonators

❷Frequency/Capacitance

Code	Frequency/Capacitance
A	MHz with No Capacitance Built-in
T	MHz with Built-in Capacitance

❸Structure/Size

Code	Structure/Size
LS	Round Lead Type
CC	Cap Chip Type
CR/CE/CG/CN/CM	Small-cap Chip Type
CV	Monolithic Chip Type
CW	Small Monolithic Chip Type

❹Nominal Center Frequency

Expressed by four-digit alphanumerics. The unit is in hertz (Hz).
Decimal point is expressed by capital letter "**M**."

❺Design

Code	Design
G	Thickness Shear mode
T/V	Thickness Expander mode
X	Thickness Expander mode (3rd overtone)

❻Initial Frequency Tolerance

Code	Initial Frequency Tolerance
5	±0.5%
3	±0.3%
2	±0.2%
1	±0.1%
H	±0.07%

❼Load Capacity

Code	Load Capacity
1	5/6pF
2	10pF
3	15pF
4	22pF
5	30/33/39pF
6	47pF

❽Individual Specification

Code	Individual Specification
***	Three-digit alphanumerics express "Individual Specification."

With standard products, "❽Individual Specification" and "❾Packaging" is omitted.

❾Packaging

Code	Packaging
-B0	Bulk
-A0	Radial Taping H₀=18mm
-R0/*R0	Plastic Taping ø=180mm Reel
-R1	Plastic Taping ø=330mm Reel

• Radial taping is applied to lead type and plastic taping to chip type.
• In case of CSACN and CSACM series, the hyphen "**-**" is replaced to a figure which means frequency rank. This figure zero "**0**" signifies standard part number.

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Ceramic Resonators (CERALOCK®)

MHz Chip Type -Tight Frequency Tolerance for Automotive-

Chip type CERALOCK(R) with built-in load capacitors provides high accuracy in an extremely small package. MURATA's frequency adjustment and package technology expertise has enabled the development of the chip CERALOCK(R) with built-in load capacitors.
This diverse series owes its development to MURATA's original mass production techniques and high reliability, and has achieved importance in the worldwide automotive market.

CSTCR_G15C
4.00-7.99MHz

∗: EIAJ Monthly Code

(in mm)

■ Features

1. The series are high accuracy resonators whose total tolerance is available for less than ±3,000ppm.
2. The series has high reliability and is available for a wide temperature range.
3. Oscillation circuits do not require external load capacitors.
4. The series is available for a wide frequency range.
5. The resonators are extremely small and have a low profile.
6. No adjustment is necessary for oscillation circuits.

CSTCE_G15C
8.00-13.99MHz

∗: EIAJ Monthly Code

(in mm)

■ Applications

1. Cluster panel and Control panel
2. Safety control
   (Anti-lock Brake System, Electronic Stability Control, Airbag, etc.)
3. Engine ECU, Electronic Power Steering, Immobilizer, etc.
4. Car Air conditioner, Power Window, Remote Keyless Entry system, etc.
5. Intelligent Transportation System
   (Lane Keeping System, Millimeter wave radar, etc.)
6. Battery control for hybrid cars

CSTCE_V13C
14.00-20.00MHz
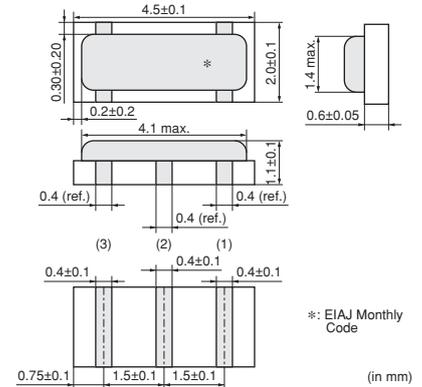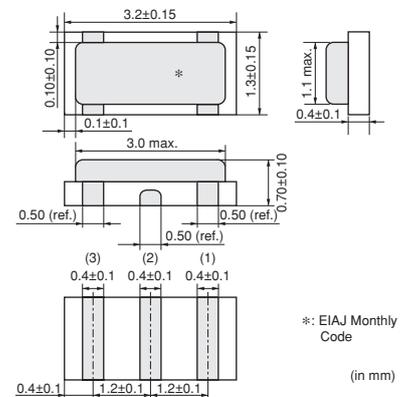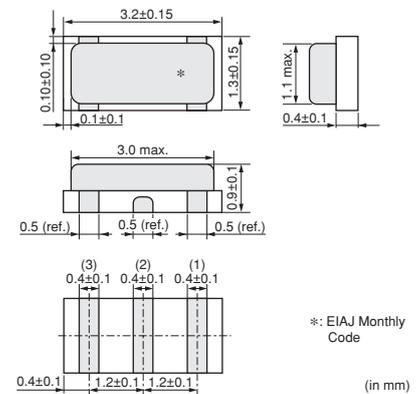
∗: EIAJ Monthly Code

(in mm)

| Part Number	Frequency (MHz)	Initial Tolerance	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCR_G15C	4.00 to 7.99	±0.1%	±0.13	-40 to 125
CSTCE_G15C	8.00 to 13.99	±0.1%	±0.13	-40 to 125
CSTCE_V13C	14.00 to 20.00	±0.1%	±0.13	-40 to 125

Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

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■ Oscillation Frequency Measuring Circuit
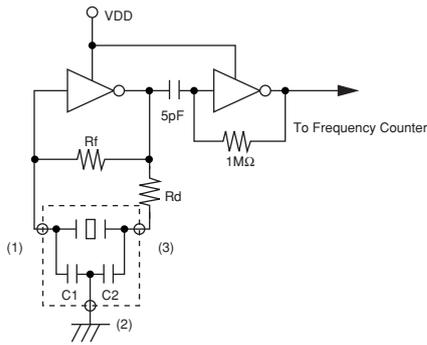
■ Standard Land Pattern Dimensions
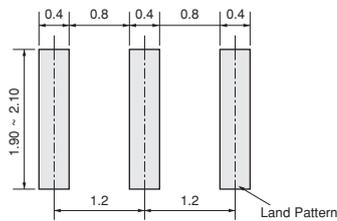
CSTCR_G15C
(* This Land Pattern is not common to CSTCR_G.)
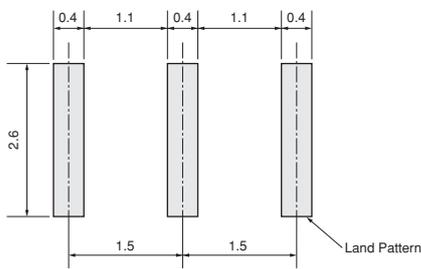
(in mm)

CSTCE_G15C
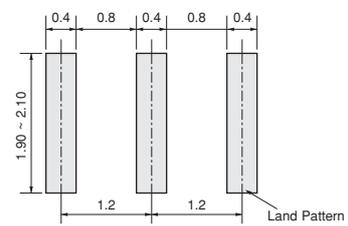
(in mm)

CSTCE_V13C
(* This Land Pattern is not common to CSTCE_V.)

(in mm)

■ Frequency Temperature Characteristics

CSTCR_G15C

CSTCE_G15C

CSTCE_V13C

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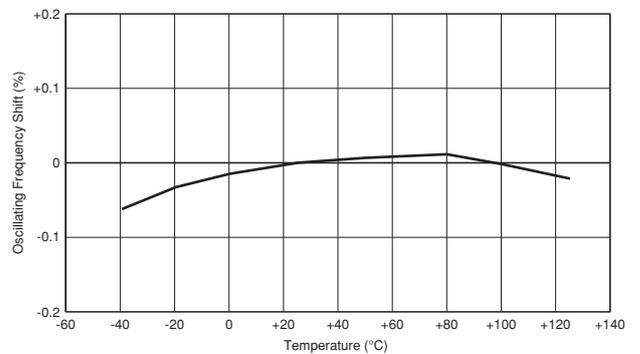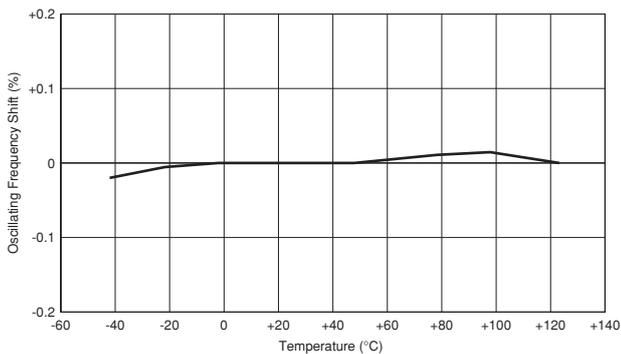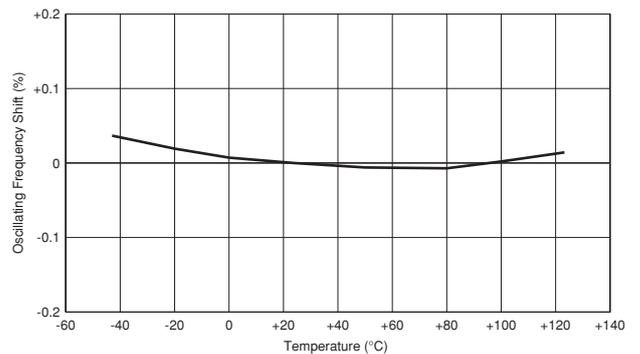
1 Application Circuits Utilization

■ TMP92CD54IF (Toshiba)
16-bit Microcomputer

Vcc3=3.3V   Vcc5=5.0V
0.1µF

H1   H2

IC : TMP92CD54IF

74   72   L
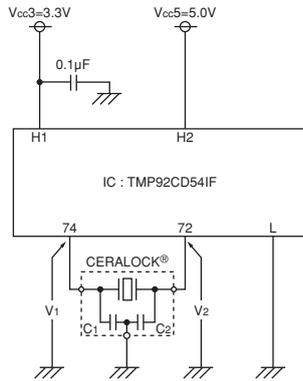
CERALOCK®
V1   V2
C1   C2

H1: 36, 68, 86
H2: 2, 4, 15, 40, 50, 61, 75
L: 1, 3, 13, 38, 51, 63, 73, 88

CERALOCK®: CSTCE10M0G15C□□-R0
C1=33pF (Typ.)
C2=33pF (Typ.)

■ MB90F387 (Fujitsu)
16-bit Microcomputer

Vcc=5.0V

H

IC : MB90F387

27   28   26   L
0.1µF
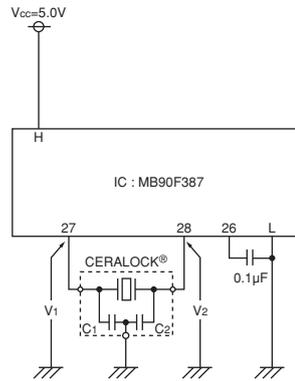
CERALOCK®
V1   V2
C1   C2

H: 1, 2, 21, 22, 24
L: 20, 23, 25, 48

CERALOCK®: CSTCE8M00G15C□□-R0
C1=33pF (Typ.)
C2=33pF (Typ.)

■ MC68HC908AZ60AVFU (Freescale)
8-bit Microcomputer

Vdd=5.0V

EVALUATION BOARD
IC : MC68HC908AZ60AVFU

59   58   GND
1MΩ
CERALOCK®
V1   V2
C1   C2
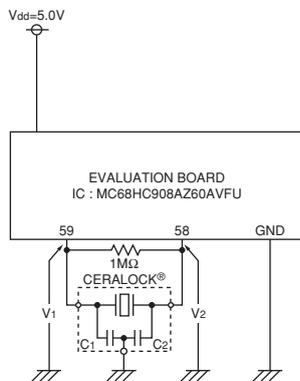
CERALOCK®: CSTCE16M0V13C□□-R0
C1=15pF (Typ.)
C2=15pF (Typ.)

■ ST72F561 (HS) (ST Microelectronics)
8-bit Microcomputer

Vdd=5.0V

H   60

IC : ST72F561 (HS)

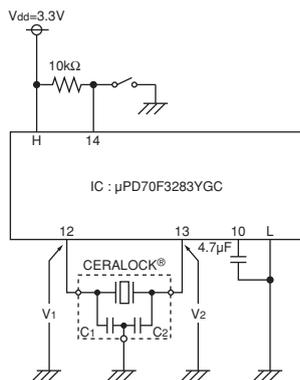1   2   L
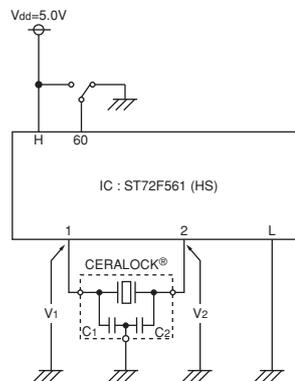
CERALOCK®
V1   V2
C1   C2

H: 9, 25, 41, 57, 58
L: 8, 24, 40, 55, 56

CERALOCK®: CSTCE8M00G15A□□-R0
C1=33pF (Typ.)
C2=33pF (Typ.)

■ µPD70F3283YGC (Renesas)
32-bit Microcomputer

Vdd=3.3V

10kΩ

H   14

IC : µPD70F3283YGC

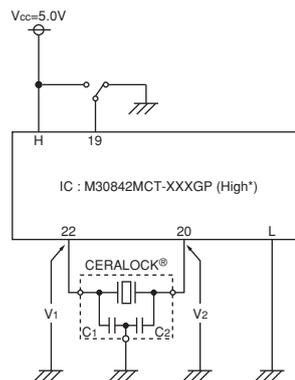12   13   10   L
4.7µF

CERALOCK®
V1   V2
C1   C2

H: 1, 5, 9, 34, 70
L: 2, 8, 11, 15, 33, 69

CERALOCK®: CSTCE10M0G15C□□-R0
C1=33pF (Typ.)
C2=33pF (Typ.)

■ M30842MCT-XXXGP (Renesas)
16-bit Microcomputer

Vcc=5.0V

H   19

IC : M30842MCT-XXXGP (High*)

22   20   L

CERALOCK®
V1   V2
C1   C2

H: 23, 24, 37, 39, 59, 74, 91, 118, 122,
   132, 142, 143
L: 15, 16, 21, 36, 41, 57, 76, 93,
   110~113, 120, 121, 130, 140

*High: XIN-XOUT Drive Capacity Select Bit

CERALOCK®: CSTCE8M00G15C□□-R0
C1=33pF (Typ.)
C2=33pF (Typ.)

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Ceramic Resonators (CERALOCK®)

MHz Chip Type -Standard Frequency Tolerance for Automotive-

2

Chip type CERALOCK(R) with built-in load capacitors provides high accuracy in an extremely small package. MURATA's frequency adjustment and package technology expertise has enabled the development of the chip CERALOCK(R) with built-in load capacitors.
This diverse series owes its development to MURATA's original mass production techniques and high reliability, and has achieved importance in the worldwide automotive market.

■ Features

1. The series has high reliability and is available for a wide temperature range.
2. Oscillation circuits do not require external load capacitors.
3. The series is available in a wide frequency range.
4. The resonators are extremely small and have a low profile.
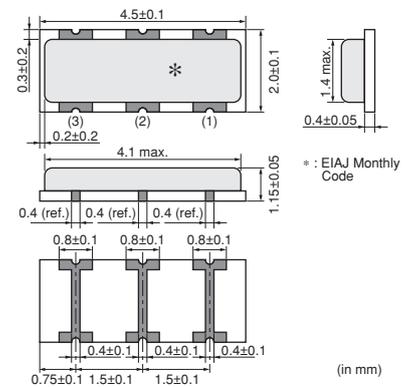5. No adjustment is necessary for oscillation circuits.

■ Applications

1. Cluster panel and Control panel
2. Safety control
   (Anti-lock Brake System, Electronic Stability Control, Airbag, etc.)
3. Engine ECU, Electronic Power Steering, Immobilizer, etc.
4. Car Air conditioner, Power Window, Remote Keyless Entry system, etc.
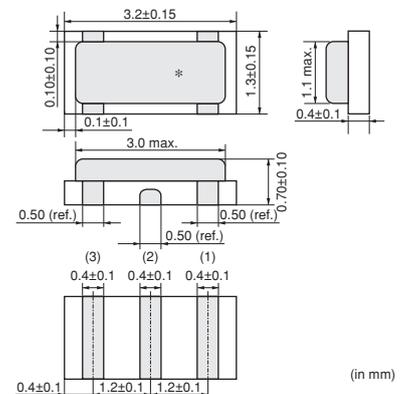5. Electronic Toll Collection system, Car Navigation, etc.
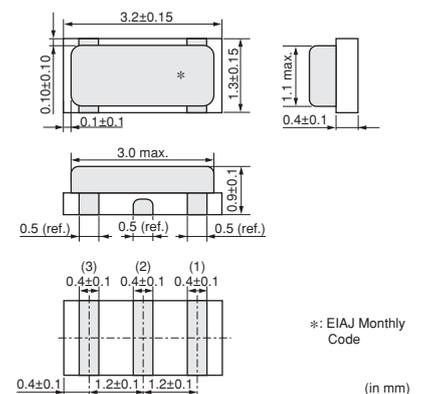
CSTCC_G_A
2.00-3.99MHz
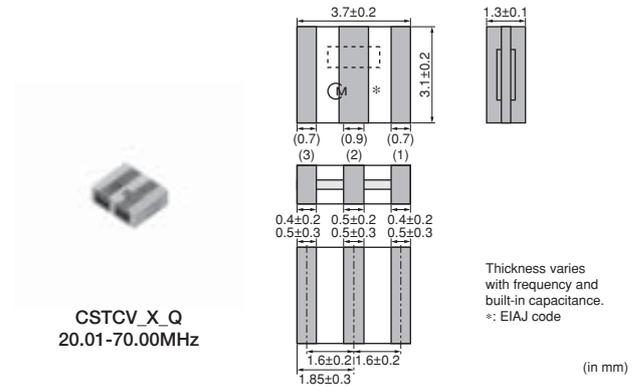
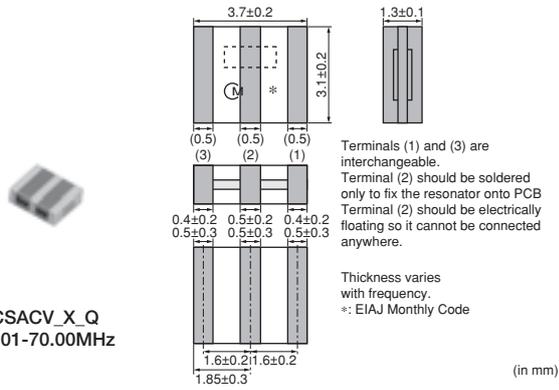CSTCR_G_B
4.00-7.99MHz

CSTCE_G_A
8.00-13.99MHz

CSTCE_V_C
14.00-20.00MHz

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Continued from the preceding page.

3.7±0.2 1.3±0.1 3.1±0.2

(0.5) (0.5) (0.5)
(3) (2) (1)

0.4±0.2 0.5±0.2 0.4±0.2
0.5±0.3 0.5±0.3 0.5±0.3

Terminals (1) and (3) are interchangeable.
Terminal (2) should be soldered only to fix the resonator onto PCB
Terminal (2) should be electrically floating so it cannot be connected anywhere.

Thickness varies with frequency.
∗: EIAJ Monthly Code

1.6±0.2 1.6±0.2
1.85±0.3

CSACV_X_Q
20.01-70.00MHz

(in mm)

3.7±0.2 1.3±0.1 3.1±0.2

(0.7) (0.9) (0.7)
(3) (2) (1)

0.4±0.2 0.5±0.2 0.4±0.2
0.5±0.3 0.5±0.3 0.5±0.3

Thickness varies with frequency and built-in capacitance.
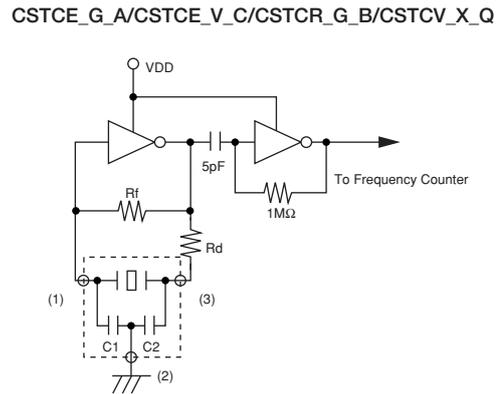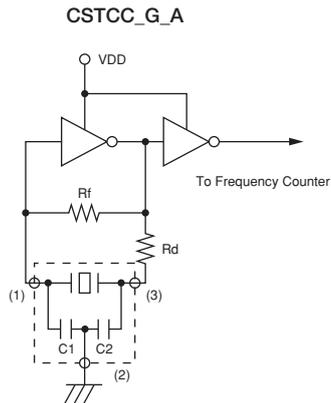∗: EIAJ code

1.6±0.2 1.6±0.2
1.85±0.3

CSTCV_X_Q
20.01-70.00MHz

(in mm)

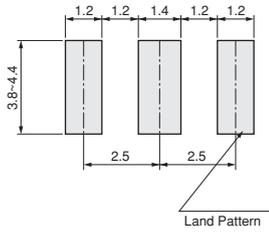| Part Number	Frequency (MHz)	Initial Tolerance	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCC_G_A	2.00 to 3.99	±0.5%	±0.4 [-0.6% to +0.3%:Built-in Capacitance 47pF type within Freq.2.00 to 3.49MHz]	-40 to 125
CSTCR_G_B	4.00 to 7.99	±0.5%	±0.15	-40 to 125
CSTCE_G_A	8.00 to 13.99	±0.5%	±0.2	-40 to 125
CSTCE_V_C	14.00 to 20.00	±0.5%	±0.15	-40 to 125
CSACV_X_Q	20.01 to 70.00	±0.5%	±0.3	-40 to 125
CSTCV_X_Q	20.01 to 70.00	±0.5%	±0.3	-40 to 125

Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

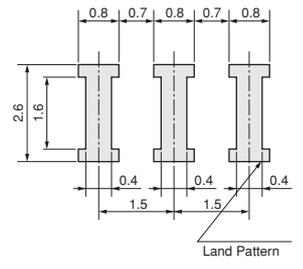## ■ Oscillation Frequency Measuring Circuit

CSTCC_G_A

VDD

Rf
Rd
To Frequency Counter
(1) (3)
C1 C2
(2)

CSTCE_G_A/CSTCE_V_C/CSTCR_G_B/CSTCV_X_Q

VDD

Rf
5pF
1MΩ
Rd
To Frequency Counter
(1) (3)
C1 C2
(2)

CSACV_X_Q

22μF
0.01μF
VDD

Rf
To Frequency Counter
CL1
CL2

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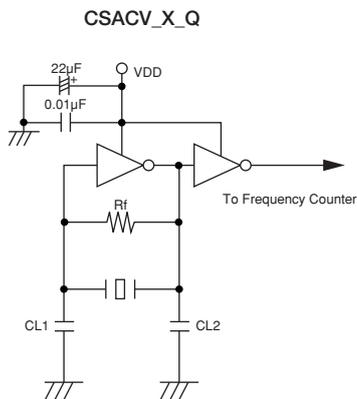
■ Standard Land Pattern Dimensions

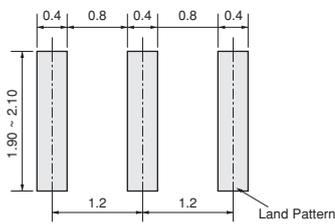### CSTCC_G_A

(in mm)

CSTCR_G_B
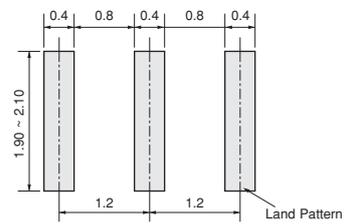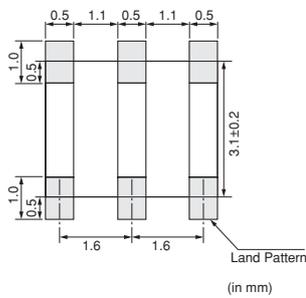

(in mm)

CSTCE_G_A

(in mm)

CSTCE_V_C
(* This Land Pattern is not common to CSTCE_V.)
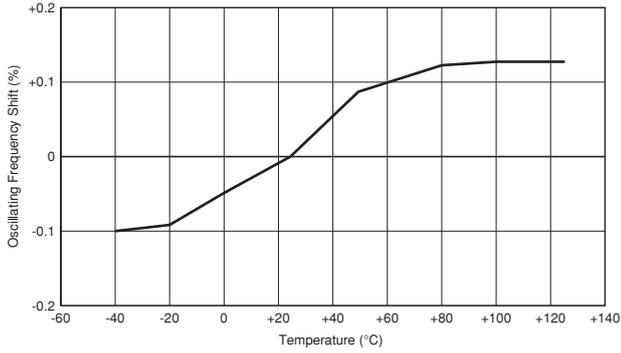

(in mm)
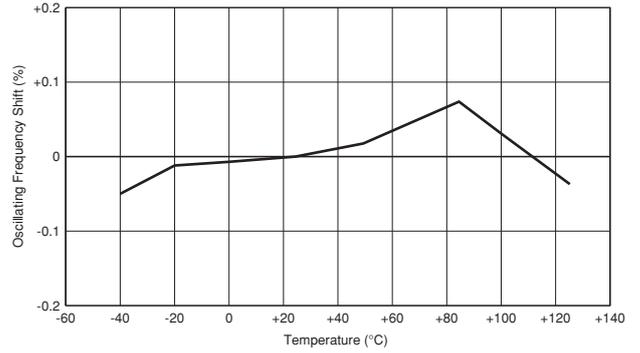
CSTCV_X_Q

(in mm)

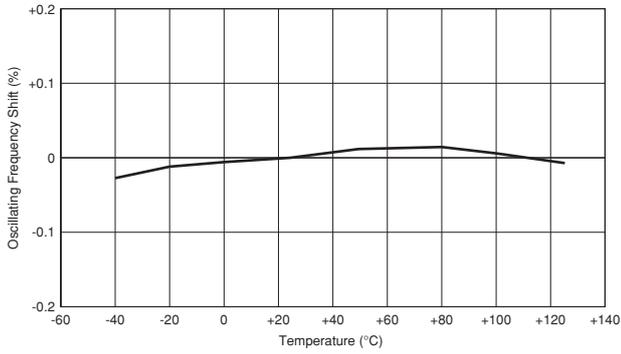### CSACV_X_Q

(in mm)

muRata
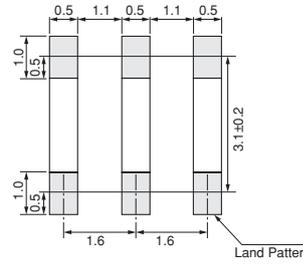
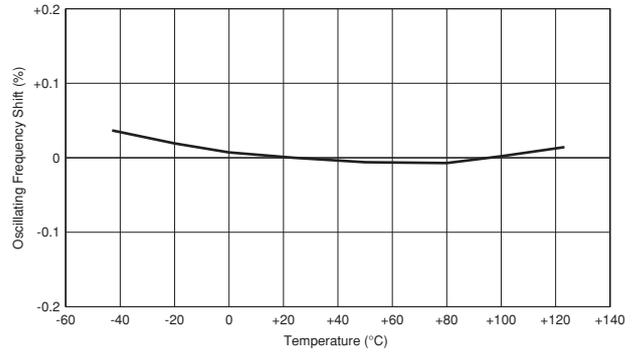## ■ Frequency Temperature Characteristics

CSTCC_G_A

CSTCR_G_B

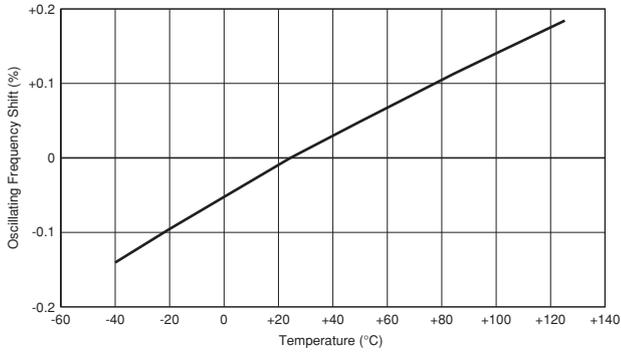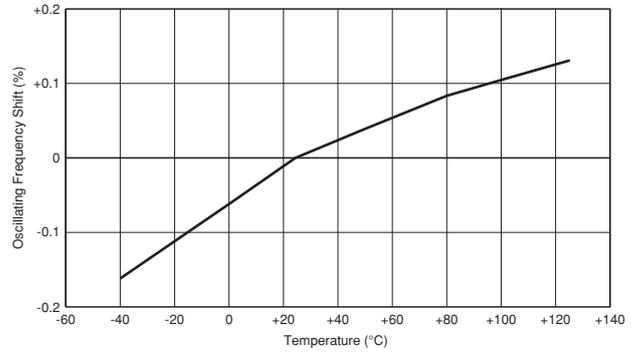CSTCE_G_A

CSTCE_V_C

CSTCV_X_Q

CSACV_X_Q

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Application Circuits Utilization

2

■ µPD78F9222MC-5A4 (Renesas)
8-bit Microcomputer

$V_{dd}=5.0V$ $V'_{dd}=7.0V$

$10k\Omega$

H   6

IC : µPD78F9222MC-5A4

2   3   8   L

CERALOCK®

V_1 V_2

C_1 C_2
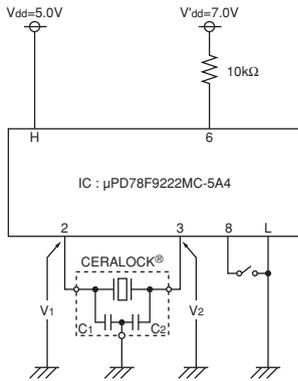
H: 5, 20
L: 1

CERALOCK®: CSTCR6M00G55B-R0
C_1=39pF (Typ.)
C_2=39pF (Typ.)

■ M30260F8AGP (Renesas)
16-bit Microcomputer

$V_{cc}=5.0V$

H   7

IC : M30260F8AGP (High*)

23   24   L

CERALOCK®
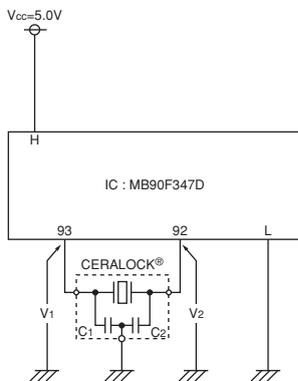
V_1 V_2

C_1 C_2
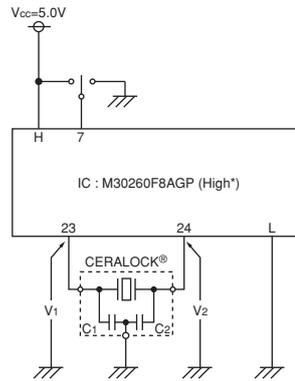
H: 11, 46, 47, 48
L: 4, 9, 44

*High: XIN-XOUT Drive Capacity Select Bit

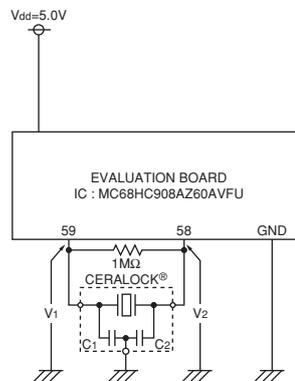CERALOCK®: CSTCE10M0G55A-R0
C_1=33pF (Typ.)
C_2=33pF (Typ.)

■ MB90F347D (Fujitsu)
16-bit Microcomputer

$V_{cc}=5.0V$

H

IC : MB90F347D

93   92   L

CERALOCK®

V_1 V_2

C_1 C_2

H: 15, 32, 65, 90
L: 16, 35, 44, 66, 91

CERALOCK®: CSTCE8M00G55A-R0
C_1=33pF (Typ.)
C_2=33pF (Typ.)

■ MC68HC908AZ60AVFU (Freescale)
8-bit Microcomputer

$V_{dd}=5.0V$

EVALUATION BOARD
IC : MC68HC908AZ60AVFU

59   58   GND

$1M\Omega$
CERALOCK®

V_1 V_2

C_1 C_2

CERALOCK®: CSTCE16M0V53C-R0
C_1=15pF (Typ.)
C_2=15pF (Typ.)

■ ST72F324J6T3 (MS) (ST Microelectronics)
8-bit Microcomputer

$V_{dd}=5.0V$

H

IC : ST72F324J6T3 (MS)

42   41   L

CERALOCK®

V_1 V_2

C_1 C_2
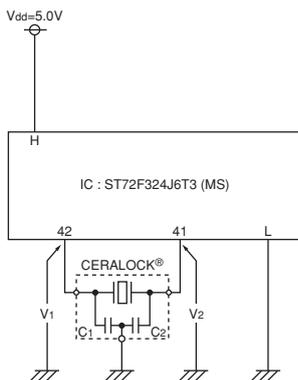
H: 13, 21, 32, 43
L: 14, 22, 33, 39, 40

CERALOCK®: CSTCR4M00G55B-R0
C_1=39pF (Typ.)
C_2=39pF (Typ.)

■ PIC12F675-I/P (HS) (Microchip)
8-bit Microcomputer

$V_{dd}=5.0V$

H

IC : PIC12F675-I/P(HS)

2   3   L

$1M\Omega$
CERALOCK®

V_1 V_2

C_1 C_2
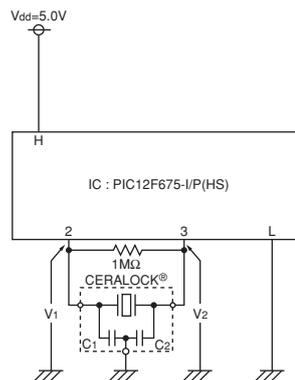
H: 1
L: 4, 8

CERALOCK®: CSTCE8M00G52A-R0
C_1=10pF (Typ.)
C_2=10pF (Typ.)

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Notice for Automotive

■ Soldering and Mounting (CSTCC/CSTCR/CSTCE_V/CSTCE_G Series)

1. Soldering

(1) Reflow soldering

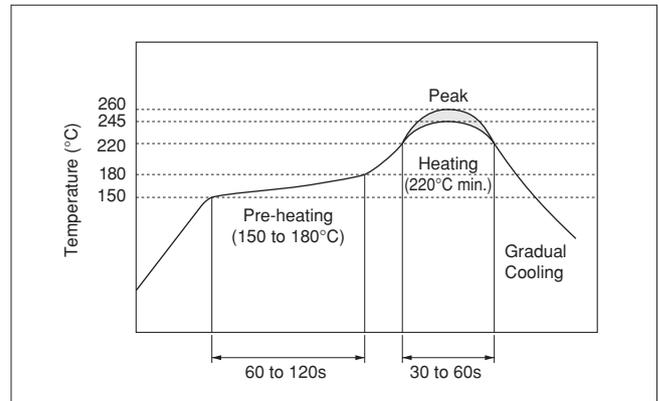Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
Peak Temperature	upper limit: 260°C	1s max.
	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.
Watt	30W max.
Shape of the soldering iron	ø3mm max.
Soldering Time	5s max. at one terminal
Solder	Sn-3.0Ag-0.5Cu

(3) Solder Volume

Please make the solder volume less than the height of the substrate to avoid damage to the seal between the metal cap and the substrate.

(4) Other

Do not reuse components removed from a circuit board after soldering.

(5) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.

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◺ Continued from the preceding page.

2. Wash

(1) Cleaning Solvents
HCFC, Isopropanol, Tap water, Demineralized water,
Cleanthrough750H, Pine alpha 100S, Techno care FRW

(2) Temperature Difference : dT *1
dT≦60°C (dT=Component-solvent)
*1 ex. If the component is immersed at +90°C into
cleaning solvent at +60°C, then dT=30°C.

(3) Conditions
  (a) Ultrasonic Wash
    1 minute max. in above solvent at +60°C max.
    (Frequency: 28kHz, Output: 20W/l)

  (b) Immersion Wash
    5 minutes max. in above solvent at +60°C max.
  (c) Shower or Rinse Wash
    5 minutes max. in above solvent at +60°C max.

(4) Drying
5 minutes max. by air blow at +80°C max.

(5) Other
  (a) Total washing time should be within 10 minutes.
  (b) The component may be damaged if it is washed with
    chlorine, petroleum, or alkali cleaning solvent.

3. Coating

Conformal coating of the component is acceptable.
However, the resin material, curing temperature, and
other process conditions should be evaluated to confirm
stable electrical characteristics are maintained.

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Notice for Automotive

■ Soldering and Mounting (CSTCV/CSACV Series)

1. Soldering

(1) Reflow soldering
Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.
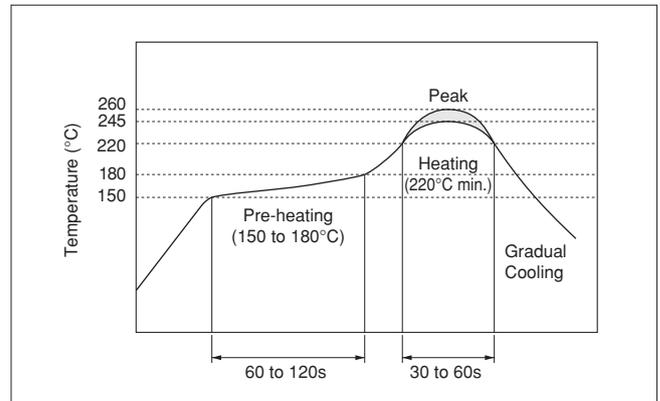
Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
Peak Temperature	upper limit: 260°C	1s max.
	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron
If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.
Watt	30W max.
Shape of the soldering iron	ø3mm max.
Soldering Time	5s max. at one terminal
Solder	Sn-3.0Ag-0.5Cu

(3) Other
Do not reuse components removed from a circuit board after soldering.

(4) Conditions for Placement Machines
The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.

2. Wash

(1) Cleaning Solvents
HCFC, Isopropanol, Tap water, Demineralized water, Cleanthrough750H, Pine alpha 100S, Techno care FRW

(2) Temperature Difference : dT *1
dT≦60°C (dT=Component-solvent)
*1 ex. If the component is immersed at +90°C into cleaning solvent at +60°C, then dT=30°C.

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Mar.17,2015

Notice for Automotive

◱ Continued from the preceding page.

(3) Conditions
    (a) Ultrasonic Wash
      1 minute max. in above solvent at +60°C max.
      (Frequency: 28kHz, Output: 20W/l)

    (b) Immersion Wash
      5 minutes max. in above solvent at +60°C max.
    (c) Shower or Rinse Wash
      5 minutes max. in above solvent at +60°C max.

(4) Drying
    5 minutes max. by air blow at +80°C max.

(5) Other
    (a) Total washing time should be within 10 minutes.
    (b) The component may be damaged if it is washed with
      chlorine, petroleum, or alkali cleaning solvent.

3. Coating
Conformal coating of the component is acceptable.
However, the resin material, curing temperature, and
other process conditions should be evaluated to confirm
stable electrical characteristics are maintained.

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Notice for Automotive

■ Storage and Operating Conditions

1. Product Storage Conditions
   Please store the products in a room where the temperature/humidity is stable, and avoid such places where there are large temperature changes. Please store the products under the following conditions:
   Temperature: -10 to +40°C
   Humidity: 15 to 85% R.H.

2. Expiration Date on Storage
   Expiration date (Shelf life) of the products is six months after delivery under the conditions of a sealed and unopened package. Please use the products within six months after delivery. If you store the products for a long time (more than six months), use carefully because the products may be degraded in solderability and/or rusty.
   Please confirm solderability and characteristics for the products regularly.

3. Notice on Product Storage
   (1) Please do not store the products in a chemical atmosphere (Acids, Alkali, Bases, Organic gas, Sulfides and so on), because the characteristics may be reduced in quality, and/or be degraded in the solderability due to the storage in a chemical atmosphere.
   (2) Please do not put the products directly on the floor without anything under them to avoid damp and/or dusty places.
   (3) Please do not store the products in places such as: in a damp heated place, in a place where direct sunlight comes in, in a place applying vibrations.
   (4) Please use the products immediately after the package is opened, because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage under the poor conditions.
   (5) Please do not drop the products to avoid cracking of ceramic elements.

4. Other
   Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm that stable electrical characteristics are maintained.
   Please be sure to consult with our sales representatives or engineers whenever and prior to using the products.

■ Rating

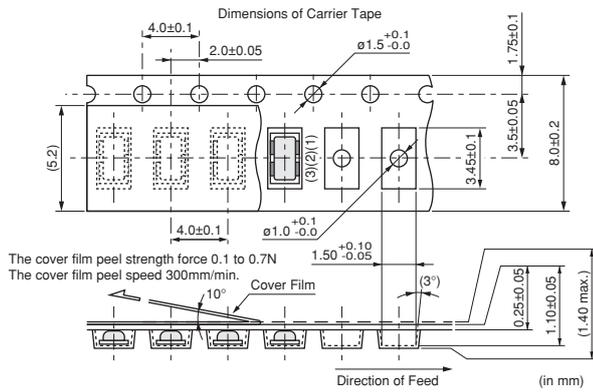The component may be damaged if excessive mechanical stress is applied.

■ Handling

"CERALOCK" may stop oscillating or oscillate irregularly under improper circuit conditions.
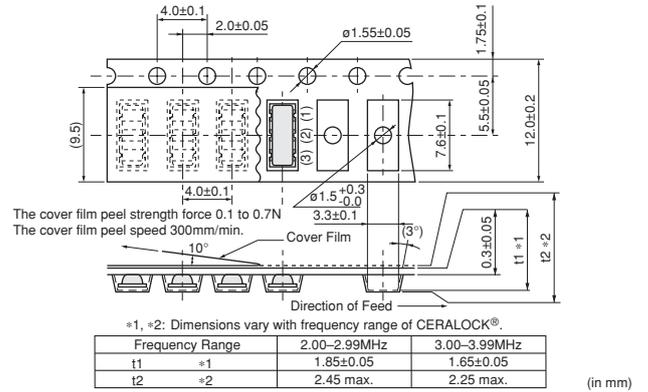
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Packaging for Automotive

■ Minimum Quantity

Part Number	Plastic Tape ø180mm	Plastic Tape ø330mm	Bulk	Reel Dimensions
CSTCC_G_A	2,000	6,000	500	a
CSTCR_G_B	3,000	9,000	500	a
CSTCR_G15C	3,000	9,000	500	a
CSTCE_G_A	3,000	9,000	500	b
CSTCE_G15C	3,000	9,000	500	b
CSTCE_V_C	3,000	9,000	500	b
CSTCE_V13C	3,000	9,000	500	b
CSTCV_X_Q	2,000	6,000	500	a
CSACV_X_Q	2,000	6,000	500	a

The order quantity should be an integral multiple of the "Minimum Quantity" shown above.

(pcs.)

■ Dimensions of Reel

a

Trailer
160-190

Leader
Cover Film

Empty   Components   Empty
160 min.

400-560

ø180 $^{0}_{-1.5}$
ø13.0±0.2
2.0±0.5
13.0 $^{+1.0}_{0}$
17.0±1.0

b

Trailer
160-190

Leader
Cover Film

Empty   Components   Empty
160 min.

400-560

ø180 $^{0}_{-1.5}$
ø13.0±0.2
2.0±0.5
9.0 $^{+1.0}_{0}$
13.0±1.0

(in mm)

■ Dimensions of Taping

CSTCR_G15C

4.0±0.1
2.0±0.05
ø1.5 $^{+0.1}_{-0}$
1.75±0.1
(9.5)
5.5±0.05
4.7±0.1
(3)(2)(1)
12.0±0.2
4.0±0.1
ø1.5 $^{+0.1}_{-0}$
2.2±0.1
(3°)

The cover film peel strength force 0.1 to 0.7N
The cover film peel speed 300mm/min.

Cover Film
10°
0.3±0.05
1.25±0.05
(1.85 max.)
Direction of Feed
(in mm)

CSTCE_G15C

4.0±0.1
2.0±0.05
ø1.5 $^{+0.1}_{-0.05}$
1.75±0.1
(5.2)
3.5±0.05
3.40 $^{+0.10}_{-0.05}$
(3)(2)(1)
8.0±0.2
4.0±0.1
ø1.0 $^{+0.2}_{-0.0}$
1.50 $^{+0.10}_{-0.05}$
(3°)

The cover film peel strength force 0.1 to 0.7N
The cover film peel speed 300mm/min.

Cover Film
10°
0.25±0.05
0.90±0.10
(1.30 max.)
Direction of Feed
(in mm)

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Packaging for Automotive

◹ Continued from the preceding page.

■ Dimensions of Taping

CSTCE_V13C

Dimensions of Carrier Tape

4.0±0.1
2.0±0.05
ø1.5 +0.1 -0.0
1.75±0.1
8.0±0.2
3.5±0.05
3.45±0.1
(5.2)
4.0±0.1
ø1.0 +0.1 -0.0
1.50 +0.10 -0.05
(3°)

The cover film peel strength force 0.1 to 0.7N
The cover film peel speed 300mm/min.
Cover Film
10°
0.25±0.05
1.10±0.05
(1.40 max.)
Direction of Feed
(in mm)

CSTCC_G_A

4.0±0.1
2.0±0.05
ø1.55±0.05
1.75±0.1
12.0±0.2
5.5±0.05
7.6±0.1
(9.5)
4.0±0.1
ø1.5 +0.3 -0.0
3.3±0.1
(3°)
0.3±0.05
t1 *1
t2 *2

The cover film peel strength force 0.1 to 0.7N
The cover film peel speed 300mm/min.
Cover Film
10°
Direction of Feed

*1, *2: Dimensions vary with frequency range of CERALOCK®.

Frequency Range	2.00–2.99MHz	3.00–3.99MHz
t1 *1	1.85±0.05	1.65±0.05
t2 *2	2.45 max.	2.25 max.

(in mm)

CSTCR_G_B

4.0±0.1
2.0±0.05
ø1.5 +0.1 -0
1.75±0.1
12.0±0.2
5.5±0.05
4.7±0.1
(9.5)
4.0±0.1
ø1.5 +0.1 -0
2.2±0.1
(3°)

The cover film peel strength force 0.1 to 0.7N
The cover film peel speed 300mm/min.
Cover Film
10°
0.3±0.05
1.25±0.1
(1.85 max.)
Direction of Feed
(in mm)

CSTCE_G_A

4.0±0.1
2.0±0.05
ø1.5 +0.1 -0.0
1.75±0.1
8.0±0.2
3.5±0.05
3.40 +0.10 -0.05
(5.2)
4.0±0.1
ø1.0 +0.2 -0
1.50 +0.10 -0.05
(3°)

The cover film peel strength force 0.1 to 0.7N
The cover film peel speed 300mm/min.
Cover Film
10°
0.25±0.05
0.90±0.10
(1.30 max.)
(in mm)

CSTCE_V_C

Dimensions of Carrier Tape

4.0±0.1
2.0±0.05
ø1.5 +0.1 -0.0
1.75±0.1
8.0±0.2
3.5±0.05
3.45±0.1
(5.2)
4.0±0.1
ø1.0 +0.1 -0.0
1.50 +0.10 -0.05
(3°)

The cover film peel strength force 0.1 to 0.7N
The cover film peel speed 300mm/min.
Cover Film
10°
0.25±0.05
1.10±0.05
(1.40 max.)
Direction of Feed
(in mm)

CSTCV_X_Q

4.0±0.1
2.0±0.1
ø1.5 +0.1 -0.0
1.75±0.1
12.0±0.2
5.5±0.1
4.1±0.1
(9.5)
4.0±0.1
ø1.5 +0.2 -0.0
3.35 +0.1 -0.05
(3°)
0.3±0.1
t1 *1
t2 *2

The cover film peel strength force 0.1 to 0.7N
The cover film peel speed 300mm/min.
Cover Film
10°
Direction of Feed

*1, *2: Dimensions vary with product thickness of CERALOCK®.

Thickness of CERALOCK®	1.50–1.40	1.30–1.20	1.10–1.00
t1 *1	1.65±0.1	1.45±0.1	1.2±0.1
t2 *2	2.0 max.	1.8 max.	1.5 max.

(in mm)

CSACV_X_Q

4.0±0.1
2.0±0.1
ø1.5 +0.1 -0.0
1.75±0.1
12.0±0.2
5.5±0.1
4.1±0.1
(9.5)
4.0±0.1
ø1.5 +0.2 -0.0
3.35 +0.1 -0.05
(3°)
0.3±0.1
t1 *1
t2 *2

The cover film peel strength force 0.1 to 0.7N
The cover film peel speed 300mm/min.
Cover Film
10°
Direction of Feed

*1, *2: Dimensions vary with product thickness of CERALOCK®.

Thickness of CERALOCK®	1.50–1.40	1.30–1.20	1.10–1.00
t1 *1	1.65±0.1	1.45±0.1	1.2±0.1
t2 *2	2.0 max.	1.8 max.	1.5 max.

(in mm)

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Ceramic Resonators (CERALOCK®)

MHz Chip Type -Tight Frequency Tolerance for Consumer/Industrial Usage-

Chip type CERALOCK(R) with built-in load capacitors provides high accuracy in an extremely small package. MURATA's frequency adjustment and packaging technology expertise has enabled the development of the chip CERALOCK(R) with built-in load capacitors. High-density mounting is made possible by the small package and the elimination of the need for an external load capacitor.

CSTCR_G15L/CSTCR_GH5L
4.00-7.99MHz

*: EIAJ Monthly Code

(in mm)

■ Features

1. Oscillation circuits do not require external load capacitors.
2. Available in a wide frequency range.
3. Extremely small and have a low profile.
4. No adjustment is necessary for oscillation circuits.

■ Applications

1. Clock oscillators for USB (Full-speed) controller ICs
2. Audio equipment and musical instruments, etc.
3. Other applications for replacement of Crystal units/ Oscillators

CSTCE_G15L/CSTCE_GH5L
8.00-13.99MHz
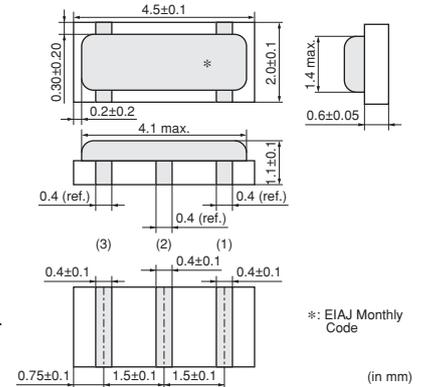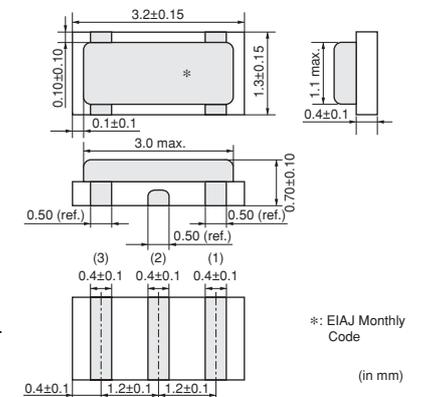
*: EIAJ Monthly Code

(in mm)

CSTCE_V13L/CSTCE_VH3L
14.00-20.00MHz

*: EIAJ Monthly Code

(in mm)

CSTCW_X11
20.01-48.00MHz

Thickness varies with frequency and built-in capacitance.
*: EIAJ code

(in mm)
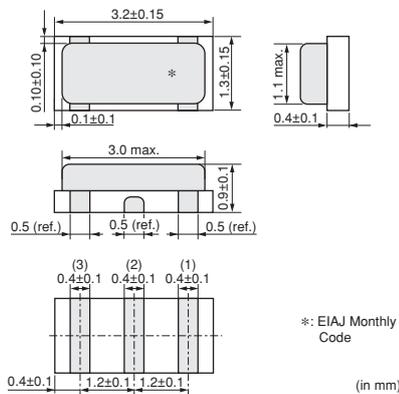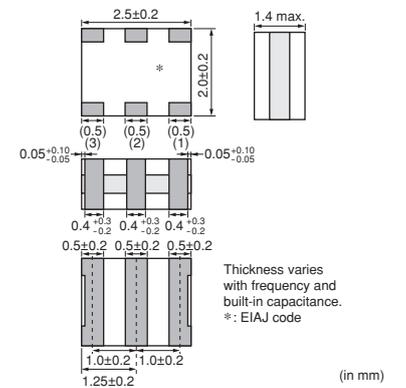
Part Number	Frequency (MHz)	Initial Tolerance	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCR_G15L	4.00 to 7.99	±0.1%	±0.08	0 to 70
CSTCR_GH5L	4.00 to 7.99	±0.07%	±0.08	0 to 70
CSTCE_G15L	8.00 to 13.99	±0.1%	±0.08	0 to 70
CSTCE_GH5L	8.00 to 13.99	±0.07%	±0.08	0 to 70
CSTCE_V13L	14.00 to 20.00	±0.1%	±0.08	0 to 70
CSTCE_VH3L	14.00 to 20.00	±0.07%	±0.08	0 to 70
CSTCW_X11	20.01 to 48.00	±0.1%	±0.1	0 to 70

Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

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■ Oscillation Frequency Measuring Circuit

**CSTCR_G15L/CSTCR_GH5L/CSTCE_G15L/
CSTCE_GH5L/CSTCE_V13L/CSTCE_VH3L**
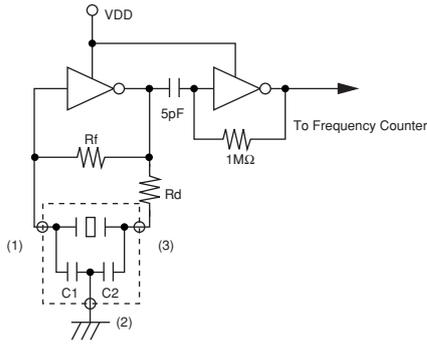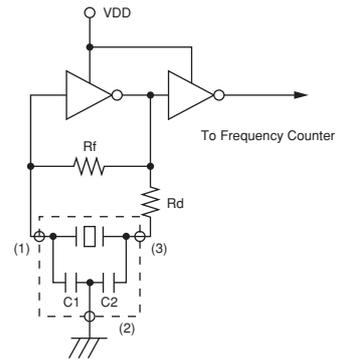
CSTCW_X11

■ Standard Land Pattern Dimensions

**CSTCR_G15L/CSTCR_GH5L
(* This Land Pattern is not common to CSTCR_G.)**

0.4 | 1.1 | 0.4 | 1.1 | 0.4

2.6

1.5 | 1.5

Land Pattern

(in mm)

CSTCE_G15L/CSTCE_GH5L

0.4 | 0.8 | 0.4 | 0.8 | 0.4

1.90 ~ 2.10

1.2 | 1.2
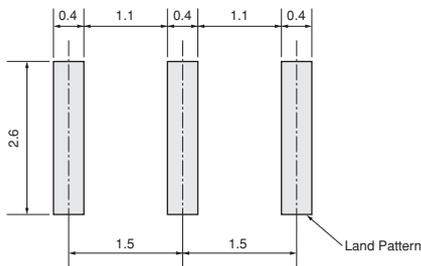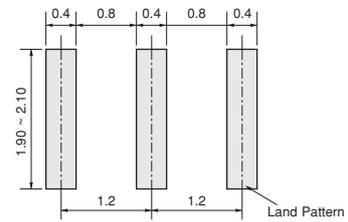
Land Pattern

(in mm)

**CSTCE_V13L/CSTCE_VH3L
(* This Land Pattern is not common to CSTCE_V.)**

0.4 | 0.8 | 0.4 | 0.8 | 0.4

1.90 ~ 2.10

1.2 | 1.2

Land Pattern

(in mm)

CSTCW_X11

0.5 0.5 0.5 0.5 0.5

0.8 | 0.3

2.0

0.8 | 0.3

1.0 | 1.0

Land Pattern

(in mm)

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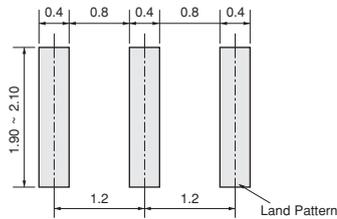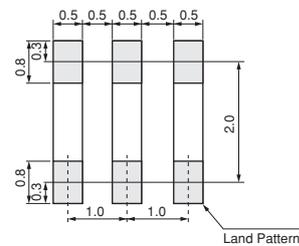
■ Frequency Temperature Characteristics

CSTCR_G15L/CSTCR_GH5L
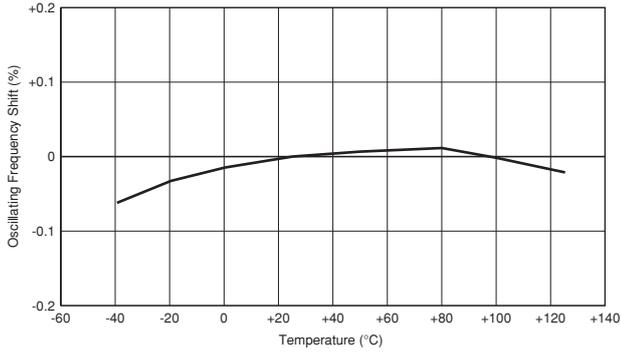
CSTCE_G15L/CSTCE_GH5L
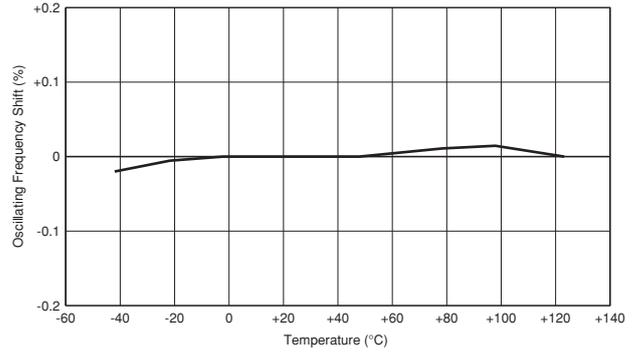
CSTCE_V13L/CSTCE_VH3L
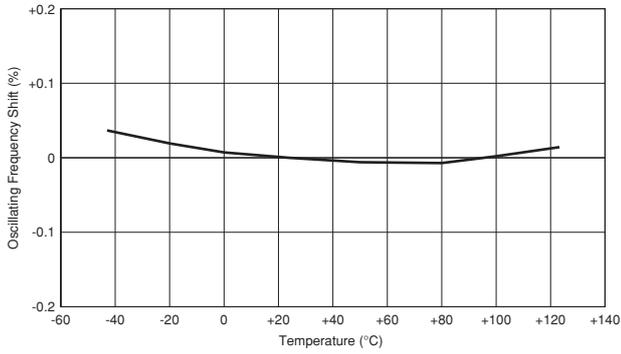
CSTCW_X11
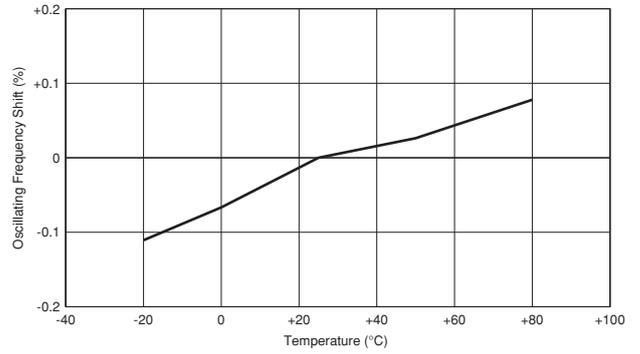
Application Circuits Utilization

3

■ M66291GP (Renesas)

USB Transceiver

V_{set}=3.3V

EVALUATION BOARD
IC : M66291GP

14   13   GND

1MΩ
CERALOCK®   220Ω

V_1 V_2

C_1 C_2
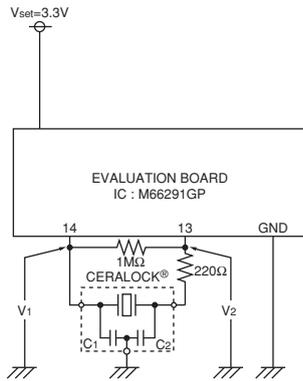
CERALOCK®: CSTCR6M00G15□□□-R0
C_1=39pF (Typ.)
C_2=39pF (Typ.)

■ MN102HF74GHL (Panasonic)

16-bit Microcontroller

V_{dd}=3.3V

Fout

H   82   18

IC : MN102HF74GHL

23   24   L

CERALOCK®

V_1 V_2

C_1 C_2
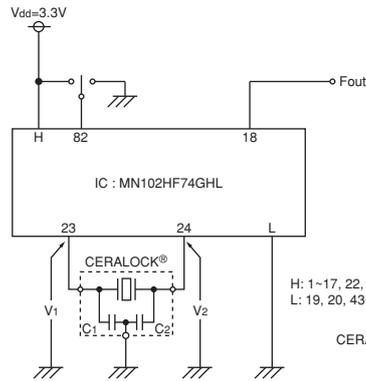
H: 1~17, 22, 25, 26~42, 54, 58~60, 66~81, 83~91
L: 19, 20, 43~53, 55~57, 61~65, 82, 92~100

CERALOCK®: CSTCE12M0G15L□□-R0
C_1=33pF (Typ.)
C_2=33pF (Typ.)

■ LC87F1964A (Sanyo)

8-bit Microcontroller

V_{dd}=5.0V

10kΩ

H   H1

IC : LC87F1964A

6   7   L1   L

470Ω   10kΩ
CERALOCK®

V_1 V_2

C_1 C_2
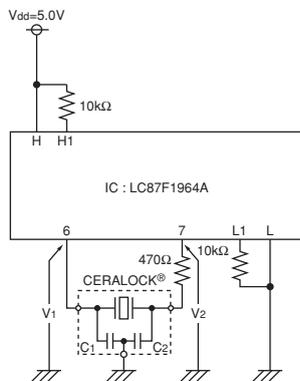
H: 8, 19, 39
L: 5, 20, 40
H1: 31, 33
L1: 29, 30, 32, 34~36

CERALOCK®: CSTCE12M0G15L□□-R0
C_1=33pF (Typ.)
C_2=33pF (Typ.)

■ TUSB2046B (Texas Instruments)

USB 4-port HUB

V_{cc}=3.3V

H

IC : TUSB2046B

30   29   GND

1MΩ
CERALOCK®

V_1 V_2

C_1 C_2
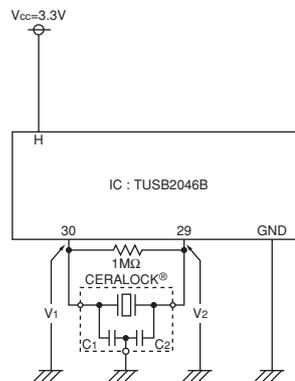
H: 3, 25
L: 7, 28

CERALOCK®: CSTCR6M00G15□□□-R0
C_1=39pF (Typ.)
C_2=39pF (Typ.)

■ ISP1181BDGG (Philips)

USB Controller
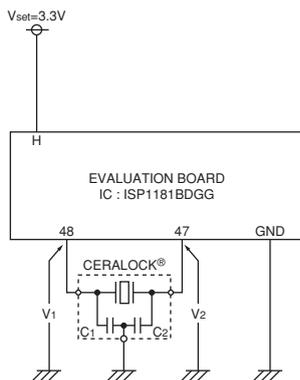
V_{set}=3.3V

H

EVALUATION BOARD
IC : ISP1181BDGG

48   47   GND

CERALOCK®

V_1 V_2

C_1 C_2

CERALOCK®: CSTCR6M00G15□□□-R0
C_1=39pF (Typ.)
C_2=39pF (Typ.)

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Ceramic Resonators (CERALOCK®)

MHz Chip Type -Standard Frequency Tolerance for Consumer/Industrial Usage-

Chip type CERALOCK(R) with built-in load capacitors provides an extremely small package.
MURATA's package technology expertise has enabled the development of the Chip CERALOCK(R) with built-in load capacitors.
High-density mounting can be realized because of the small package and the elimination of the need for an external load capacitor.

■ Features

1. Oscillation circuits do not require external load capacitors.
2. Available in a wide frequency range.
3. Extremely small and have a low profile.
4. No adjustment is necessary for oscillation circuits.

■ Applications

1. Clock oscillators for microprocessors
2. Small electronic equipment such as handheld phone, digital video camcorder (DVC), digital still camera (DSC), portable audio player, etc.
3. Storage media and memory
   (HDD, Optical storage device, FDD, Flash memory card, etc.)
4. Office automation equipment
   (Mobile PC, Mouse, Keyboard, etc.)
5. Audio-visual applications
   (TV, DVD-HDD recorder, Audio equipment, Remote control, etc.)
6. Home appliances
   (Air conditioner, Microwave oven, Refrigerator, Washing machine, etc.)

CSTCC_G
2.00-3.99MHz
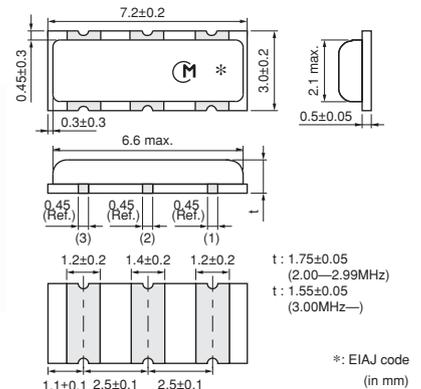
CSTCR_G
4.00-7.99MHz
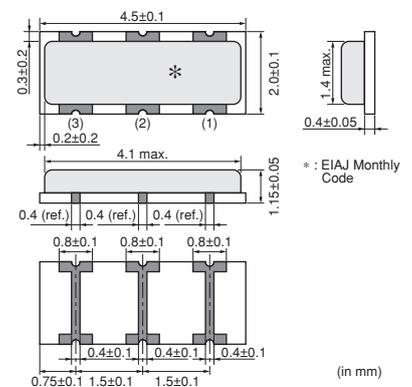
CSACN_G
4.00/6.00MHz
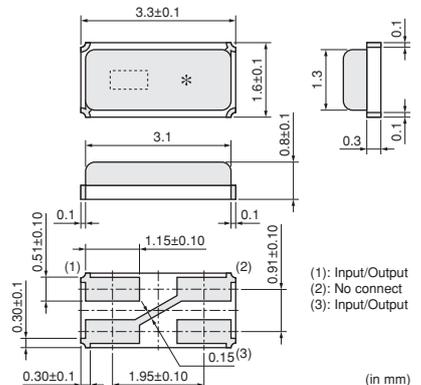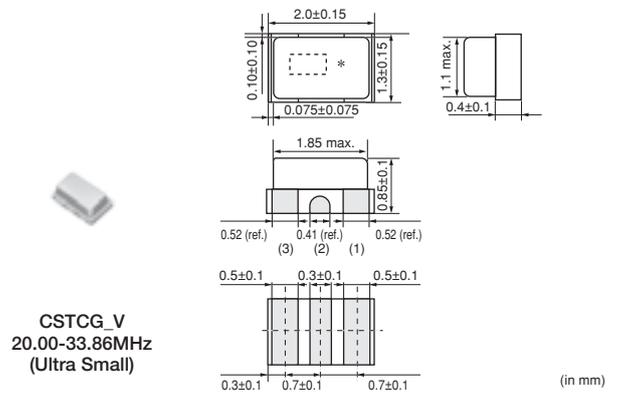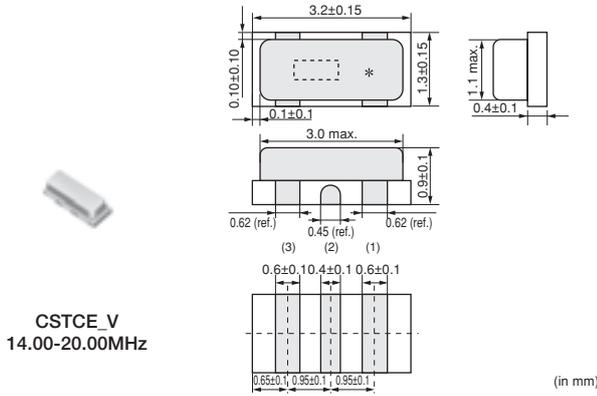

CSTCE_G/CSTCE_G_Z
8.00-13.99MHz

CSACM_G
8.00/10.00/12.00MHz

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⌐ Continued from the preceding page.

CSTCE_V
14.00-20.00MHz

CSTCG_V
20.00-33.86MHz
(Ultra Small)

(in mm)

CSACW_X
20.01-70.00MHz

Thickness varies
with frequency.
∗: EIAJ code

(in mm)

CSTCW_X
20.01-70.00MHz

Thickness varies
with frequency and
built-in capacitance.
∗: EIAJ code

(in mm)

Part Number	Frequency (MHz)	Initial Tolerance	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCC_G	2.00 to 3.99	±0.5%	±0.3 [±0.4%:Built-in Capacitance 47pF type within Freq.2.00 to 3.49MHz]	-20 to 80
CSTCR_G	4.00 to 7.99	±0.5%	±0.2	-20 to 80
CSACN_G*	4.00, 6.00	±0.5%	-0.25 to +0.2	-20 to 85
CSTCE_G	8.00 to 13.99	±0.5%	±0.2	-20 to 80
CSTCE_G_Z	8.00 to 13.99	±0.5%	±0.2	-40 to 125
CSACM_G*	8.00, 10.00, 12.00	±0.5%	-0.25 to +0.2	-20 to 85
CSTCE_V	14.00 to 20.00	±0.5%	±0.3	-20 to 80
CSTCG_V	20.00 to 33.86	±0.5%	±0.3	-20 to 80
CSACW_X	20.01 to 70.00	±0.5%	±0.2	-20 to 80
CSTCW_X	20.01 to 70.00	±0.5%	±0.2	-20 to 80

Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.
*: Please refer to Notice.

■ Oscillation Frequency Measuring Circuit

CSTCR_G/CSTCE_G/CSTCE_G_Z/CSTCE_V/CSTCG_V
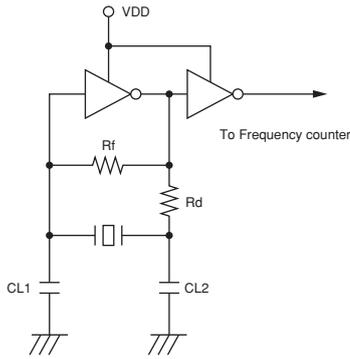
CSTCC_G/CSTCW_X
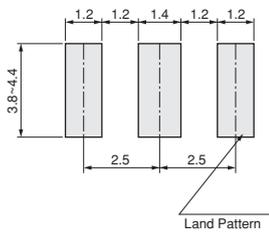
Continued on the following page. ↗

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⬂ Continued from the preceding page.

■ Oscillation Frequency Measuring Circuit

CSACN_G/CSACM_G/CSACW_X

■ Standard Land Pattern Dimensions

CSTCC_G

(in mm)

CSTCR_G
(* This Land Pattern is not common to
CSTCR_G15C, CSTCR_G15L, CSTCR_GH5L.)
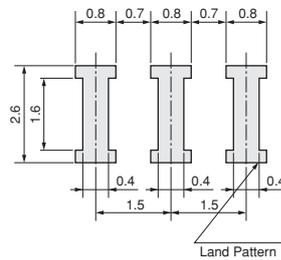
(in mm)

CSACN_G
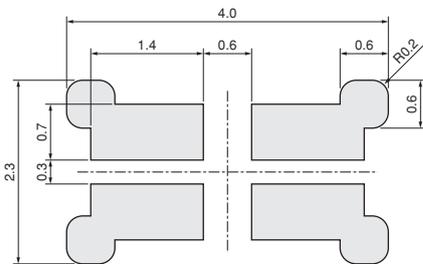
(in mm)

CSTCE_G/CSTCE_G_Z
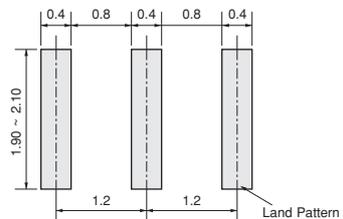
(in mm)

CSACM_G
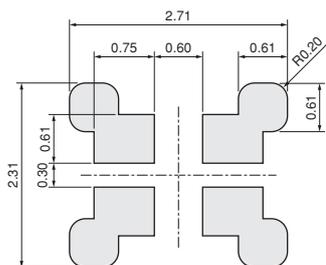
(in mm)

CSTCE_V
(* This Land Pattern is not common to
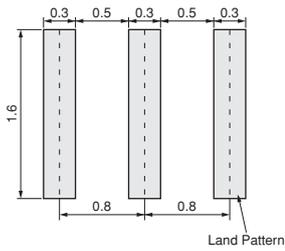### CSTCE_V13C, CSTCE_V_C, CSTCE_V13L, CSTCE_VH3L.)

(in mm)

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◩ Continued from the preceding page.

■ Standard Land Pattern Dimensions

CSTCG_V

Land Pattern

(in mm)

CSACW_X

Land Pattern

(in mm)

CSTCW_X

Land Pattern
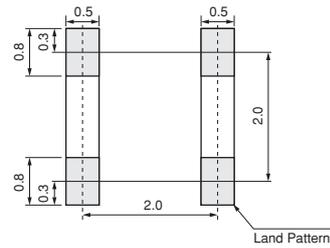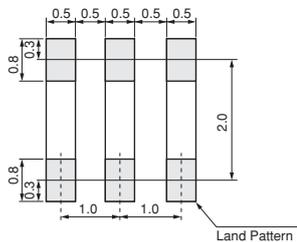
(in mm)

■ Frequency Temperature Characteristics

CSTCC_G
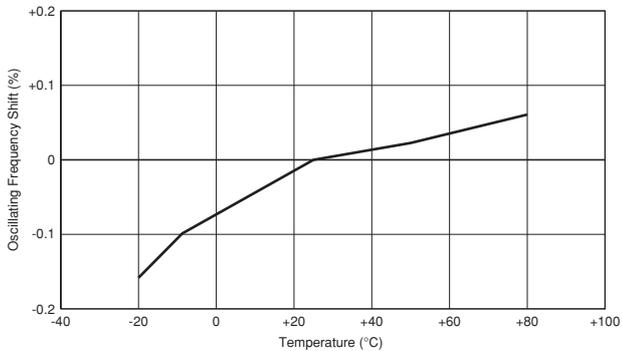
CSTCR_G

CSACN_G

CSTCE_G/CSTCE_G_Z

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■ Frequency Temperature Characteristics

CSACM_G

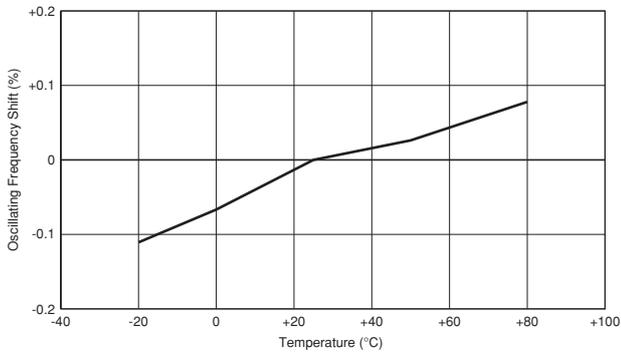### CSTCE_V
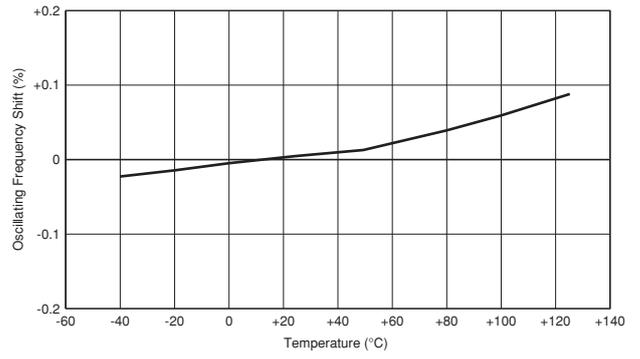
CSTCG_V

CSACW_X
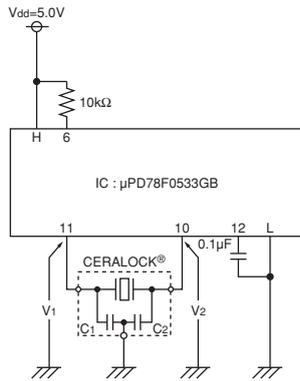

CSTCW_X

4

muRata
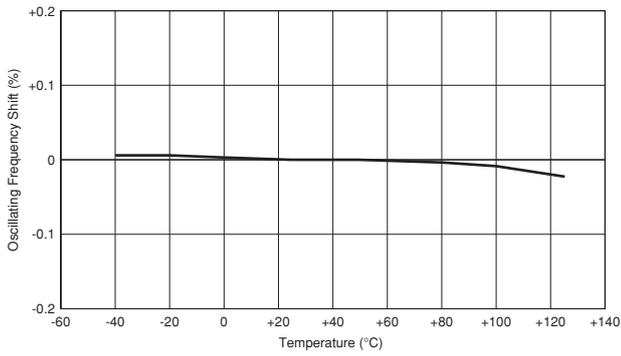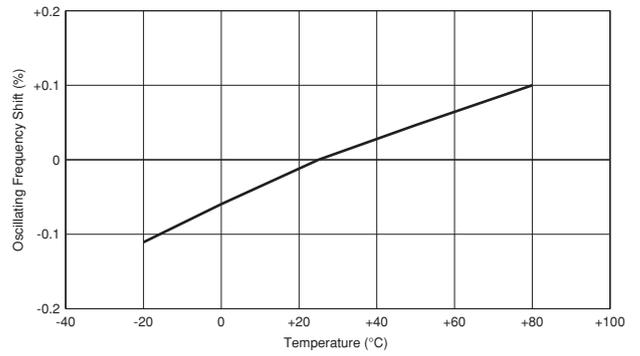
Application Circuits Utilization

■ μPD78F0533GB (Renesas)
8-bit Microcomputer

H: 15, 16, 47
L: 9, 13, 14, 48

CERALOCK®: CSTCR4M00G55-R0
C_1=39pF (Typ.)
C_2=39pF (Typ.)

■ TMP19A43FDXBG (Toshiba)
32-bit Microcomputer
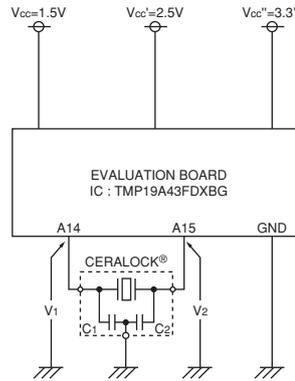
Xin: A14
Xout: A15

CERALOCK®: CSTCE10M0G52-R0
C_1=10pF (Typ.)
C_2=10pF (Typ.)

■ MN103SFC2D (Panasonic)
32-bit Microcomputer
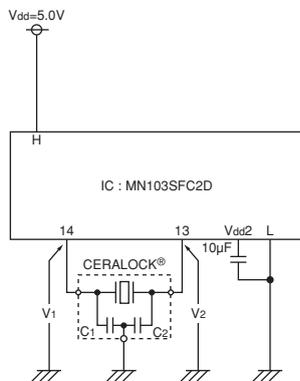
H: 9, 17, 34
L: 7, 15, 36
Vdd2: 16, 38

CERALOCK®: CSTCR5M00G55Z-R0
C_1=39pF (Typ.)
C_2=39pF (Typ.)

■ MB95F128H (Fujitsu)
8-bit Microcomputer
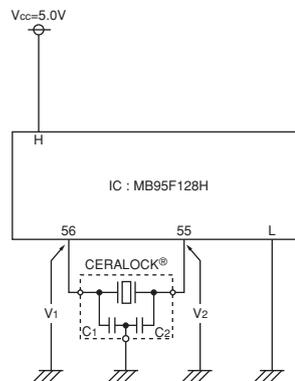
H: 3, 28, 51, 79
L: 4, 29, 54, 57

CERALOCK®: CSTCE8M00G52-R0
C_1=10pF (Typ.)
C_2=10pF (Typ.)

■ PIC16F716-I/SO (Microchip)
8-bit Microcomputer
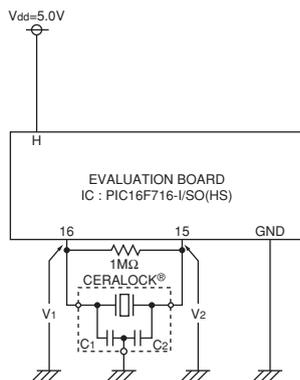
CERALOCK®: CSTCE12M0G52-R0
C_1=10pF (Typ.)
C_2=10pF (Typ.)

■ HD64F36077GH (Renesas)
16-bit Microcomputer
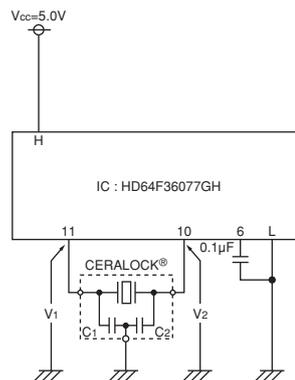
H: 3, 7, 12
L: 8, 9

CERALOCK®: CSTCE8M00G52-R0
C_1=10pF (Typ.)
C_2=10pF (Typ.)

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Application Circuits Utilization

◣ Continued from the preceding page.

■ µPD70F3215HYGC (Renesas)
32-bit Microcomputer
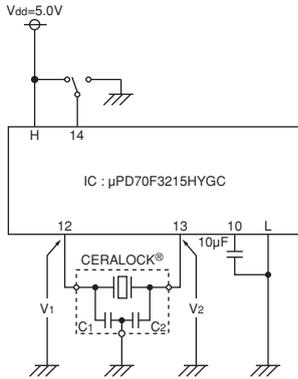
H: 1, 5, 9, 34, 70
L: 2, 8, 11, 33, 69

CERALOCK®: CSTCR5M00G55-R0
C$_1$=39pF (Typ.)
C$_2$=39pF (Typ.)

■ ATmega128 (Atmel)
8-bit Microcomputer
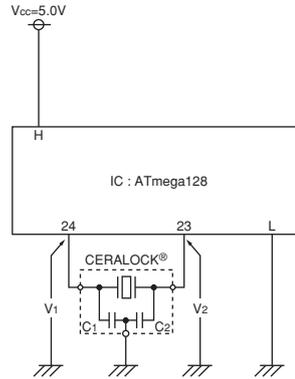
H: 21, 52, 64
L: 22, 53, 63

CERALOCK®: CSTCE8M00G52-R0
C$_1$=10pF (Typ.)
C$_2$=10pF (Typ.)

■ ST7FLITE29F2B6 (ST Microelectronics)
8-bit Microcomputer
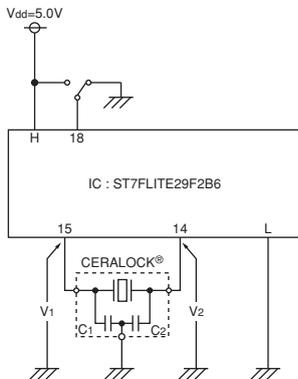
H: 17
L: 16

CERALOCK®: CSTCE16M0V53-R0
C$_1$=15pF (Typ.)
C$_2$=15pF (Typ.)

■ TMS320F2810PBKA (Texas Instruments)
32-bit Microcomputer
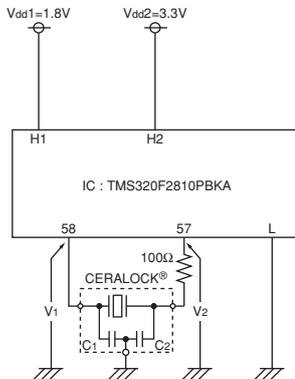
H1: 20, 29, 42, 56, 63, 74, 82, 94, 99,
    100, 102, 110, 114
H2: 1, 13, 14, 25, 49, 52, 83, 104, 118
L: 12, 15, 17, 26, 30, 39, 53, 59, 62, 73,
   88, 95, 103, 109, 115, 117, 128

CERALOCK®: CSTCE15M0V53-R0
C$_1$=15pF (Typ.)
C$_2$=15pF (Typ.)

4

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P16E.pdf
Mar.17,2015

Ceramic Resonators (CERALOCK®)

MHz Lead Type -Standard Frequency Tolerance for Consumer/Industrial Usage-

MURATA's ceramic resonator, CERALOCK(R) with built-in load capacitors, has been widely applied as the most suitable component for clock oscillators in a broad range of microprocessors.

The CSTLS series can be used in the design of oscillation circuits not requiring external load capacitors, enabling both high-density mounting and cost reduction.

CSTLS_G
3.40-10.00MHz

*** : Weekly Date Code
(in mm)

■ Features

1. Oscillation circuits do not require external load capacitors.
   There is some variation in built-in capacitance values applicable to various IC.
2. Stable over a wide temperature range.
3. Compact, lightweight and exhibit superior shock resistance performance.
4. Enable the design of oscillator circuits requiring no adjustment.
5. Cost-effective and reliable availability

■ Applications

1. DTMF generators
2. Clock oscillators for microcomputers
3. Remote control units
4. Automated office equipment
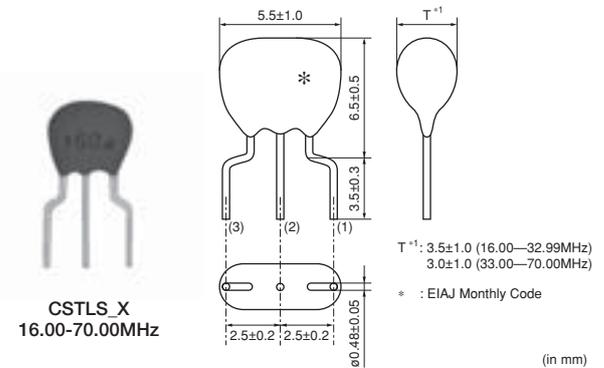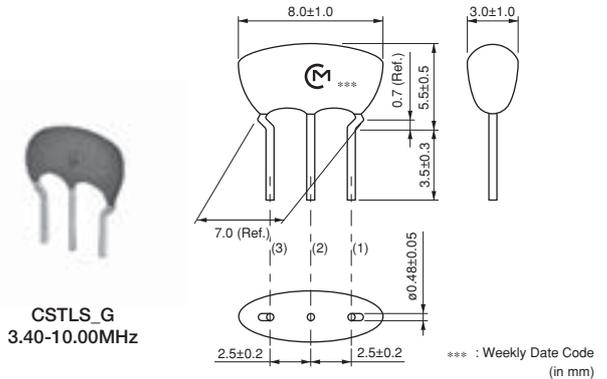
CSTLS_X
16.00-70.00MHz

T *1: 3.5±1.0 (16.00—32.99MHz)
3.0±1.0 (33.00—70.00MHz)

* : EIAJ Monthly Code

(in mm)

Part Number	Frequency (MHz)	Initial Tolerance	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTLS_G	3.40 to 10.00	±0.5%	±0.2 [-0.4% to +0.2%:Built-in Capacitance 47pF type]	-20 to 80
CSTLS_X	16.00 to 70.00	±0.5%	±0.2	-20 to 80

Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.
The order quantity should be an integral multiple of the "Minimum Quantity" shown in the packaging page.

■ Oscillation Frequency Measuring Circuit
CSTLS_G/CSTLS_X

VDD

To Frequency Counter

Rf

Rd

(1) (3)

C1 C2

(2)

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■ Frequency Temperature Characteristics

CSTLS_G

CSTLS_X

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Application Circuits Utilization

■ M38235G6HP (Renesas)
8-bit Microcomputer

Vcc=5.0V

M38235G6HP
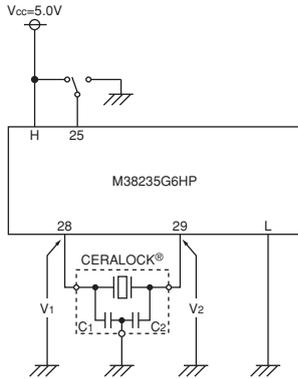
CERALOCK®

H: 71
L: 30, 73

CERALOCK®: CSTLS8M00G53-B0
C1=15pF (Typ.)
C2=15pF (Typ.)

■ LC87F5G32A (Sanyo)
8-bit Microcomputer

Vdd=5.0V

510Ω   47000pF

10kΩ 10kΩ 100pF

IC : LC87F5G32A

2.2kF   10kF
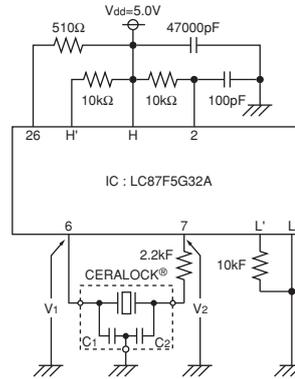
CERALOCK®

H: 8, 19, 39
L: 5, 20, 40
H': 29, 31, 35
L': 30, 32~34, 36

CERALOCK®: CSTLS5M00G53-B0
C1=15pF (Typ.)
C2=15pF (Typ.)

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Mar.17,2015

Notice for Consumer/Industrial Usage -MHz Chip Type-

■ Soldering and Mounting (CSTCC Series)

1. Soldering

(1) Reflow soldering

Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
Peak Temperature	upper limit: 260°C	1s max.
	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.
Watt	30W max.
Shape of the soldering iron	ø3mm max.
Soldering Time	5s max. at one terminal
Solder	Sn-3.0Ag-0.5Cu

(3) Solder Volume

Please make the solder volume less than the height of the substrate to avoid damage to the seal between the metal cap and the substrate.

(4) Other

Do not reuse components removed from a circuit board after soldering.

(5) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.

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Notice for Consumer/Industrial Usage -MHz Chip Type-

◥ Continued from the preceding page.

2. Wash
Some series do not withstand washing.
Please check the list at right before use.

Series	Wash
CSTCC (2.00 to 3.49MHz)	Not Available
CSTCC (3.50 to 3.99MHz)	Available

(1) Cleaning Solvents
HCFC, Isopropanol, Tap water, Demineralized water,
Cleanthrough750H, Pine alpha 100S, Techno care FRW

(2) Temperature Difference : dT *1
dT≦60°C (dT=Component-solvent)
*1 ex. If the component is immersed at +90°C into
cleaning solvent at +60°C, then dT=30°C.

(3) Conditions
(a) Ultrasonic Wash
1 minute max. in above solvent at +60°C max.
(Frequency: 28kHz, Output: 20W/l)

(b) Immersion Wash
5 minutes max. in above solvent at +60°C max.
(c) Shower or Rinse Wash
5 minutes max. in above solvent at +60°C max.

(4) Drying
5 minutes max. by air blowing at +80°C max.

(5) Other
(a) Total washing time should be within 10 minutes.
(b) The component may be damaged if it is washed with
chlorine, petroleum, or alkali cleaning solvent.

3. Coating
Conformal coating of the component is acceptable.
However, the resin material, curing temperature, and
other process conditions should be evaluated to confirm
stable electrical characteristics are maintained.

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Notice for Consumer/Industrial Usage -MHz Chip Type-

■ Soldering and Mounting (CSTCR/CSTCE_V/CSTCG/CSACN/CSACM/CSTCE_G Series)

1. Soldering

(1) Reflow soldering

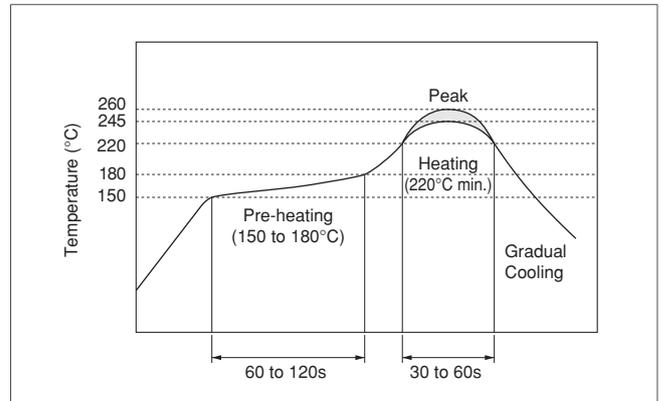Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
Peak Temperature	upper limit: 260°C	1s max.
	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.
Watt	30W max.
Shape of the soldering iron	ø3mm max.
Soldering Time	5s max. at one terminal
Solder	Sn-3.0Ag-0.5Cu

(3) Solder Volume

Please make the solder volume less than the height of the substrate to avoid damage to the seal between the metal cap and the substrate.

2. Washing / Coating

Conformal coating or washing of the component is not acceptable, because it is not hermetically sealed. Please contact us if you need a washable component.

3. CSACN/CSACM Series Oscillation Frequency

CSACN/CSACM series is a chip resonator with 2 terminals which does not have built-in load capacitors. Oscillation frequency may vary according to external load capacitance value. Its measurement circuit for standard part number is as shown in Fig.1. Please make sure if oscillation frequency is certainly within a range of frequency tolerance that brings to essential set level performance, when using other value of constant in Fig.1. Please contact us if oscillation frequency needs to be adjusted by a chip resonator itself. There would be some ranked part number that we could propose.

(4) Other

Do not reuse components removed from a circuit board after soldering.

(5) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.

IC: 1/6 TC74HCU04AF x2 (Toshiba)
VDD: +3±0.1V
Rf: 1MΩ
Rd: 1.5kΩ
CL1: 15pF±1%
CL2: 15pF±1%

Fig.1

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Notice for Consumer/Industrial Usage -MHz Chip Type-

◻ Continued from the preceding page.

■ Soldering and Mounting (CSACW/CSTCW Series)

1. Soldering

(1) Reflow soldering

Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
Peak Temperature	upper limit: 260°C	1s max.
	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.
Watt	30W max.
Shape of the soldering iron	ø3mm max.
Soldering Time	5s max. at one terminal
Solder	Sn-3.0Ag-0.5Cu

(3) Other

Do not reuse components removed from a circuit board after soldering.

(4) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.
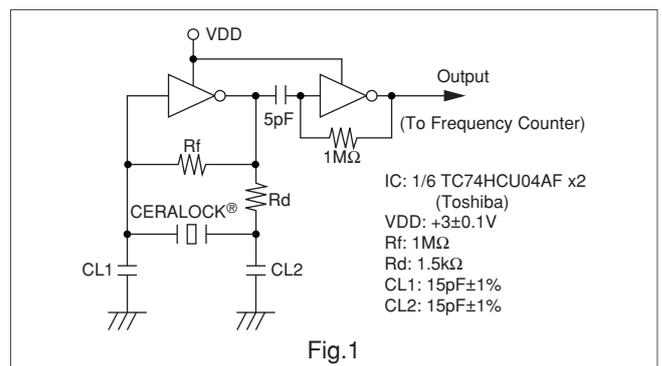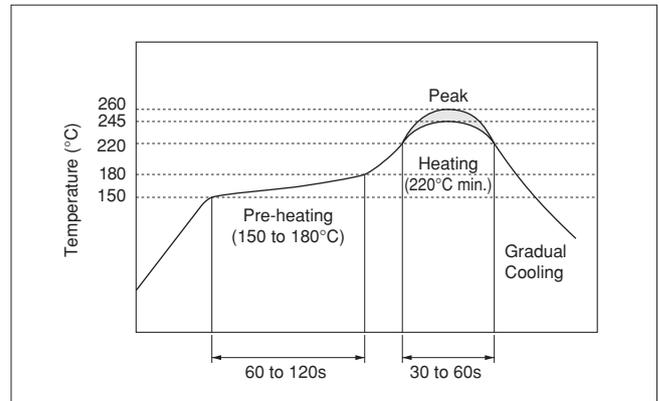
2. Washing / Coating

Conformal coating or washing of the component is not acceptable, because it is not hermetically sealed. Please contact us if you need a washable component.

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Notice for Consumer/Industrial Usage -MHz Chip Type-

■ Storage and Operating Conditions

1. Product Storage Conditions
   Please store the products in a room where the temperature/humidity is stable, and avoid such places where there are large temperature changes. Please store the products under the following conditions:
   Temperature: -10 to +40°C
   Humidity: 15 to 85% R.H.

2. Expiration Date on Storage
   Expiration date (Shelf life) of the products is six months after delivery under the conditions of a sealed and unopened package. Please use the products within six months after delivery. If you store the products for a long time (more than six months), use carefully because the products may be degraded in solderability and/or rusty.
   Please confirm solderability and characteristics for the products regularly.

3. Notice on Product Storage

  (1) Please do not store the products in a chemical atmosphere (Acids, Alkali, Bases, Organic gas, Sulfides and so on), because the characteristics may be reduced in quality, and/or be degraded in the solderability due to the storage in a chemical atmosphere.

(2) Please do not put the products directly on the floor without anything under them to avoid damp and/or dusty places.

(3) Please do not store the products in places such as: in a damp heated place, in a place where direct sunlight comes in, in a place applying vibrations.

(4) Please use the products immediately after the package is opened, because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage under the poor conditions.

(5) Please do not drop the products to avoid cracking of ceramic elements.

4. Other
   Conformal coating or washing of the component is not acceptable because it is not hermetically sealed.
   Please be sure to consult with our sales representatives or engineers whenever and prior to using the products.

■ Rating

The component may be damaged if excessive mechanical stress is applied.

■ Handling

"CERALOCK" may stop oscillating or oscillate irregularly under improper circuit conditions.

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Notice for Consumer/Industrial Usage -MHz Lead Type-

■ Soldering and Mounting

The component cannot withstand washing.
Please do not apply excessive mechanical stress to the
component and lead terminals during soldering.

■ Storage and Operating Conditions

1. Product Storage Conditions
   Please store the products in a room where the
   temperature/humidity is stable, and avoid
   such places where there are large temperature
   changes. Please store the products under the
   following conditions:
    Temperature: -10 to +40°C
    Humidity: 15 to 85% R.H.

2. Expiration Date on Storage
   Expiration date (Shelf life) of the products is six
   months after delivery under the conditions of a
   sealed and unopened package. Please use the
   products within six months after delivery. If you
   store the products for a long time (more than six
   months), use carefully because the products may
   be degraded in solderability and/or rusty.
   Please confirm solderability and characteristics
   for the products regularly.

3. Notice on Product Storage
   (1) Please do not store the products in a chemical
       atmosphere (Acids, Alkali, Bases, Organic gas,
       Sulfides and so on), because the characteristics
       may be reduced in quality, and/or be degraded in
       the solderability due to the storage in a
       chemical atmosphere.

(2) Please do not put the products directly on the
    floor without anything under them to avoid damp
    and/or dusty places.

(3) Please do not store the products in places
    such as: in a damp heated place, in a place where
    direct sunlight comes in, in a place applying
    vibrations.

(4) Please use the products immediately after the
    package is opened, because the characteristics
    may be reduced in quality, and/or be degraded in
    the solderability due to storage under the poor
    conditions.

(5) Please do not drop the products to avoid cracking
    of ceramic elements.

4. Other
   Conformal coating or washing of the component is not
   acceptable because it is not hermetically sealed.
   Please be sure to consult with our sales representatives
   or engineers whenever and prior to using the products.

■ Rating

The component may be damaged if excessive mechanical
stress is applied.

■ Handling

"CERALOCK" may stop oscillating or oscillate
irregularly under improper circuit conditions.

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Packaging for Consumer/Industrial Usage -MHz Chip Type-

■ Minimum Quantity

Part Number	Plastic Tape ø180mm	Plastic Tape ø330mm	Bulk	Reel Dimensions
CSTCC_G	2,000	6,000	500	a
CSTCR_G	3,000	9,000	500	a
CSTCR_G15L	3,000	9,000	500	a
CSTCR_GH5L	3,000	9,000	500	a
CSACN_G	3,000	-	-	b
CSTCE_G	3,000	9,000	500	b
CSTCE_G15L	3,000	9,000	500	b
CSTCE_GH5L	3,000	9,000	500	b
CSACM_G	3,000	-	-	b
CSTCE_V	3,000	9,000	500	b
CSTCE_V13L	3,000	9,000	500	b
CSTCE_VH3L	3,000	9,000	500	b
CSTCG_V	3,000	9,000	500	b
CSTCW_X	3,000	9,000	500	b
CSTCW_X11	3,000	9,000	500	b
CSACW_X	3,000	9,000	500	b

The order quantity should be an integral multiple of the "Minimum Quantity" shown above.

(pcs.)

■ Dimensions of Reel

(in mm)
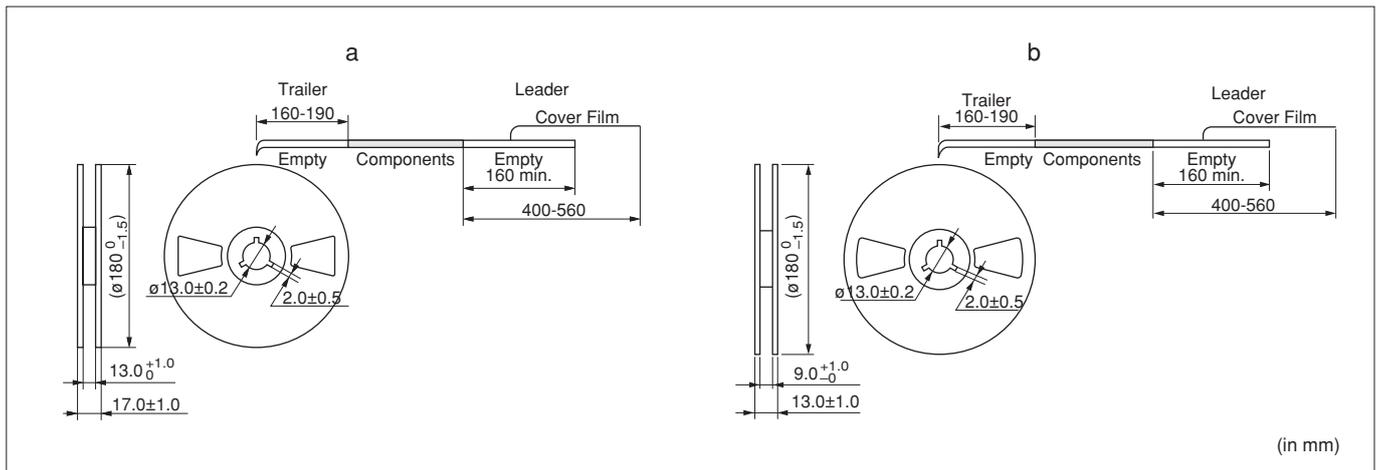
■ Dimensions of Taping
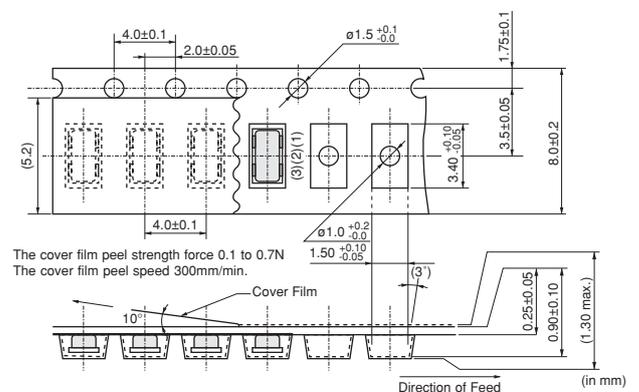
CSTCR_G15L/CSTCR_GH5L
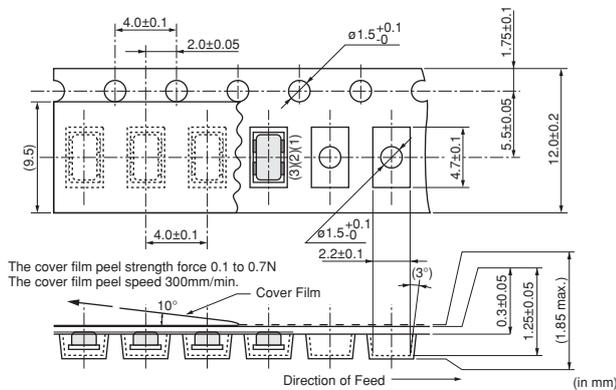
The cover film peel strength force 0.1 to 0.7N
The cover film peel speed 300mm/min.

(in mm)

CSTCE_G15L/CSTCE_GH5L

The cover film peel strength force 0.1 to 0.7N
The cover film peel speed 300mm/min.

(in mm)

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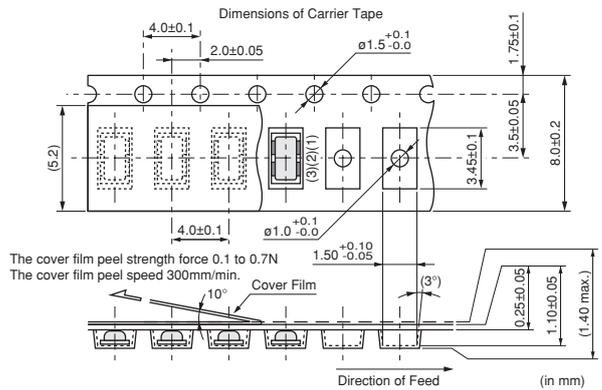## Packaging for Consumer/Industrial Usage -MHz Chip Type-

◻ Continued from the preceding page.
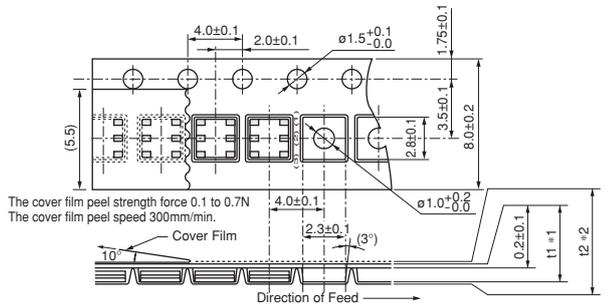
■ Dimensions of Taping

CSACN_G
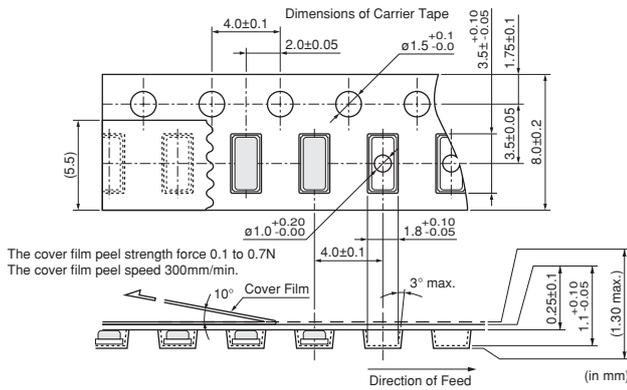
CSTCE_V13L/CSTCE_VH3L

CSTCW_X11

∗1, ∗2: Dimensions vary with product thickness of CERALOCK®.

Thickness of CERALOCK®	1.40–1.20	1.15–1.00	0.95–0.90
t1 ∗1	1.48±0.1	1.30±0.1	1.12±0.1
t2 ∗2	2.1 max.	1.9 max.	1.7 max.

(in mm)

CSTCC_G
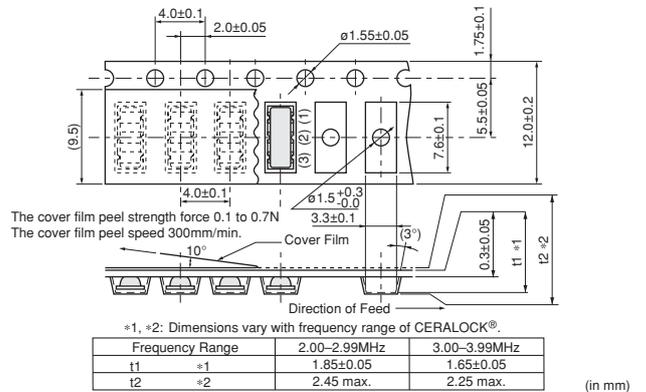
∗1, ∗2: Dimensions vary with frequency range of CERALOCK®.

Frequency Range	2.00–2.99MHz	3.00–3.99MHz
t1 ∗1	1.85±0.05	1.65±0.05
t2 ∗2	2.45 max.	2.25 max.

(in mm)

CSTCR_G

CSTCE_G

CSTCE_V

CSACM_G

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Packaging for Consumer/Industrial Usage -MHz Chip Type-

◻ Continued from the preceding page.

■ Dimensions of Taping

CSTCG_V

The cover film peel strength force 0.1 to 0.7N
The cover film peel speed 300mm/min.

(in mm)

CSACW_X

The cover film peel strength force 0.1 to 0.7N
The cover film peel speed 300mm/min.

*1, *2: Dimensions vary with product thickness of CERALOCK®.

Thickness of CERALOCK®	1.40–1.20	1.15–1.00	0.95–0.90
t1 *1	1.48±0.1	1.30±0.1	1.12±0.1
t2 *2	2.1 max.	1.9 max.	1.7 max.

(in mm)

CSTCW_X

The cover film peel strength force 0.1 to 0.7N
The cover film peel speed 300mm/min.

*1, *2: Dimensions vary with product thickness of CERALOCK®.

Thickness of CERALOCK®	1.40–1.20	1.15–1.00	0.95–0.90
t1 *1	1.48±0.1	1.30±0.1	1.12±0.1
t2 *2	2.1 max.	1.9 max.	1.7 max.

(in mm)

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Mar.17,2015

Packaging for Consumer/Industrial Usage -MHz Lead Type-

■ Minimum Quantity

Part Number	Ammo Pack	Bulk
CSTLS_G (3.40 to 10.0MHz)	2,000	500
CSTLS_X (16.00 to 70.00MHz)	2,000	500

The order quantity should be an integral multiple of the "Minimum Quantity" shown above.

(pcs.)

■ Tape Dimensions of CSTLS_G
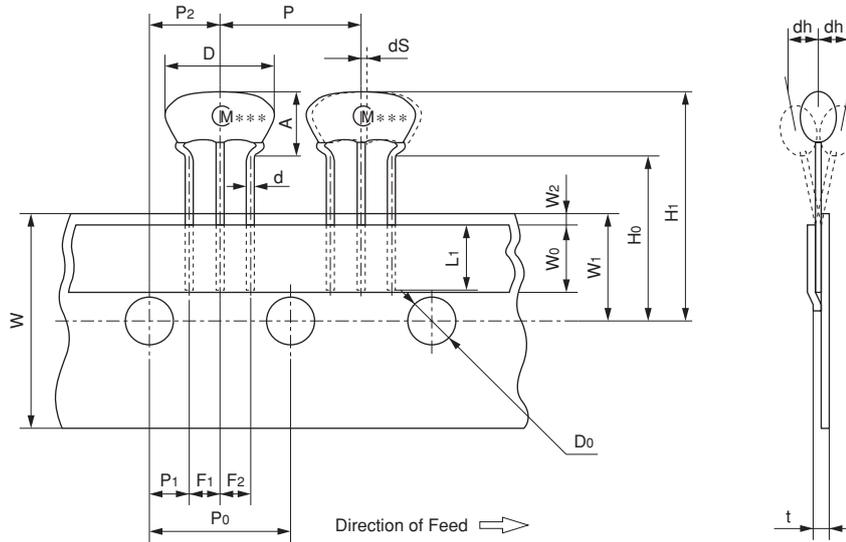
Item	Code	Dimensions	Tolerance	Remarks
Width of diameter	D	8.0	±1.0	
Height of resonator	A	5.5	±0.5	
Dimensions of terminal	d	ø0.48	±0.05	
Lead length under the hold down tape	L_1	5.0 min.	−	
Pitch of component	P	12.7	±0.5	Tolerance for Pitches 10xP0=127±1
Pitch of sprocket hole	P_0	12.7	±0.2	
Length from sprocket hole center to lead	P_1	3.85	±0.5	
Length from sprocket hole center to component center	P_2	6.35	±0.5	
Lead spacing (I)	F_1	2.5	±0.2	
Lead spacing (II)	F_2	2.5	±0.2	
Slant forward or backward	dh	0	±1.0	1mm max.
Width of carrier tape	W	18.0	±0.5	
Width of hold down tape	W_0	6.0 min.	−	Hold down tape does not exceed the carrier tape.
Position of sprocket hole	W_1	9.0	±0.5	
Gap of hold down tape and carrier tape	W_2	0	+0.5 −0	
Distance between the center of sprocket hole and lead stopper	H_0	18.0	±0.5	
Total height of resonator	H_1	23.5	±1.0	
Diameter of sprocket hole	D_0	ø4.0	±0.2	
Total tape thickness	t	0.6	±0.2	
Body tilt	dS	0	±1.0	

(in mm)

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Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

P16E.pdf
Mar.17,2015

Packaging for Consumer/Industrial Usage -MHz Lead Type-

Continued from the preceding page.

■ Tape Dimensions of CSTLS_X

Direction of Feed ⟹
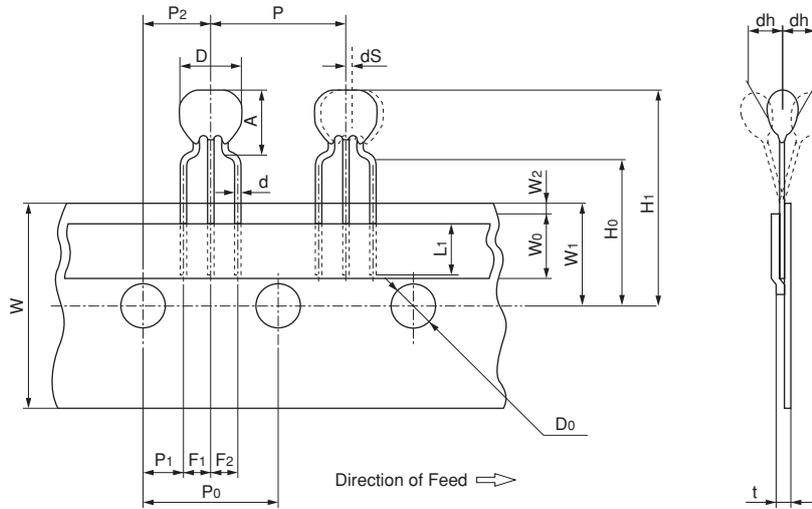
Item	Code	Dimensions	Tolerance	Remarks
Width of diameter	D	5.5	±1.0	
Height of resonator	A	6.5	±0.5	
Dimensions of terminal	d	ø0.48	±0.05	
Lead length under the hold down tape	L_1	5.0 min.	−	
Pitch of component	P	12.7	±0.5	Tolerance for Pitches $10 \times P_0 = 127 \pm 1$
Pitch of sprocket hole	P_0	12.7	±0.2	
Length from sprocket hole center to lead	P_1	3.85	±0.5	
Length from sprocket hole center to component center	P_2	6.35	±0.5	
Lead spacing (I)	F_1	2.5	±0.2	
Lead spacing (II)	F_2	2.5	±0.2	
Slant forward or backward	dh	0	±1.0	1mm max.
Width of carrier tape	W	18.0	±0.5	
Width of hold down tape	W_0	6.0 min.	−	Hold down tape does not exceed the carrier tape.
Position of sprocket hole	W_1	9.0	±0.5	
Gap of hold down tape and carrier tape	W_2	0	+0.5 −0.0	
Distance between the center of sprocket hole and lead stopper	H_0	18.0	±0.5	
Total height of resonator	H_1	24.5	±1.0	
Diameter of sprocket hole	D_0	ø4.0	±0.2	
Total tape thickness	t	0.6	±0.2	
Body tilt	dS	0	±1.0	

(in mm)

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Global Locations

For details please visit www.murata.com

⚠ Note

1 Export Control

For customers outside Japan:

No Murata products should be used or sold, through any channels, for use in the design, development, production, utilization, maintenance or operation of, or otherwise contribution to (1) any weapons (Weapons of Mass Destruction [nuclear, chemical or biological weapons or missiles] or conventional weapons) or (2) goods or systems specially designed or intended for military end-use or utilization by military end-users.

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② *Aerospace equipment*

③ *Undersea equipment*

④ *Power plant equipment*

⑤ *Medical equipment*

⑥ *Transportation equipment (vehicles, trains, ships, etc.)*

⑦ *Traffic signal equipment*

⑧ *Disaster prevention / crime prevention equipment*

⑨ *Data-processing equipment*

⑩ *Application of similar complexity and/or reliability requirements to the applications listed above*

3 Product specifications in this catalog are as of March 2015. They are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering. If there are any questions, please contact our sales representatives or product engineers.

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5 This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

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